

## FEATURES

Next generation of the [AD822](#)

Wide bandwidth: 8 MHz typical

High slew rate: +23 V/μs/−18 V/μs typical

Low input bias current: ±10 pA maximum at T<sub>A</sub> = 25°C

Low offset voltage

A grade: ±0.8 mV maximum at T<sub>A</sub> = 25°C

B grade: ±0.35 mV maximum at T<sub>A</sub> = 25°C

Low offset voltage drift

A grade: ±2 μV/°C typical, ±15 μV/°C maximum

B grade: ±2 μV/°C typical, ±5 μV/°C maximum

Input voltage range includes Pin V−

Rail-to-rail output

Input electromagnetic interference (EMI) filters

90 dB typical at f = 1000 MHz and f = 2400 MHz

Industry-standard package and pinouts

## APPLICATIONS

High output impedance sensor interfaces

Photodiode sensor interfaces

Transimpedance amplifiers

ADC drivers

Precision filters and signal conditioning

## GENERAL DESCRIPTION

The [ADA4622-2](#) is the next generation of the [AD822](#) single-supply, rail-to-rail output (RRO), precision junction field effect transistors (JFET) input op amp. The [ADA4622-2](#) includes many improvements that make it desirable as an upgrade without compromising the flexibility and ease of use that makes the [AD822](#) useful for a wide variety of applications.

The input voltage range includes the negative supply and the output swings rail-to-rail. Input EMI filters are added to increase the signal robustness in the face of closely located switching noise sources.

The speed in terms of bandwidth and slew rate is increased along with a strong output drive to improve settling time performance and enable the device to drive the inputs of modern single-ended, successive approximation register (SAR) analog-to-digital converters (ADCs).

## PIN CONFIGURATION

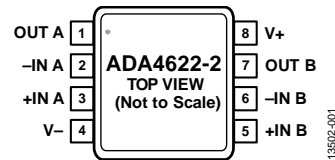


Figure 1. 8-Lead MSOP (RM Suffix) Pin Configuration (See the Pin Configurations and Function Descriptions Section for Additional Pin Configurations)

Voltage noise is reduced; broadband noise is reduced by 25% and 1/f is reduced by half while keeping the supply current the same as the [AD822](#). DC precision in the [ADA4622-2](#) improved from the [AD822](#) with half the offset and a maximum thermal drift specification added to the [ADA4622-2](#). The common-mode rejection ratio (CMRR) is improved from the [AD822](#) to make the [ADA4622-2](#) more suitable when used in noninverting gain and difference amplifier configurations.

The [ADA4622-2](#) is specified for operation over the extended industrial temperature range of −40°C to +125°C and operates from 5 V to 30 V with specifications at +5 V, ±5 V, and ±15 V. The [ADA4622-2](#) is available in 8-lead SOIC, 8-lead MSOP, and 8-lead LFCSP packages.

**TABLE OF CONTENTS**

Features .....	1	Typical Performance Characteristics .....	11
Applications.....	1	Theory Of Operation .....	23
Pin Configuration.....	1	Input Characteristics.....	23
General Description .....	1	Output Characteristics.....	24
Revision History .....	2	Applications Information .....	25
Specifications.....	3	Recommended Power Solution .....	25
Electrical Characteristics, $V_{SY} = \pm 15\text{ V}$ .....	3	Maximum Power Dissipation .....	25
Electrical Characteristics, $V_{SY} = \pm 5\text{ V}$ .....	5	Second-Order Low-Pass Filter.....	25
Electrical Characteristics, $V_{SY} = 5\text{ V}$ .....	7	Wideband Photodiode Preamplifier.....	25
Absolute Maximum Ratings.....	9	Peak Detector.....	28
Thermal Resistance .....	9	Outline Dimensions .....	29
ESD Caution.....	9	Ordering Guide .....	30
Pin Configurations and Function Descriptions .....	10		

**REVISION HISTORY**

**2/16—Rev. 0 to Rev. A**

Added 8-Lead LFCSP .....	Universal
Changes to General Description Section.....	1
Changes to Settling Time to 0.1% Parameter and Settling Time to 0.01% Parameter, Table 1 .....	4
Changes to Table 5.....	9
Added Pin Configurations and Function Descriptions Section, Figure 2, Figure 3, Table 6, Figure 4, and Table 7; Renumbered Sequentially .....	10
Changes to Figure 9.....	11
Changes to Input Characteristics Section .....	23
Changes to Recommended Power Solution Section .....	25
Changes to Wideband Photodiode Preamplifier Section .....	26
Change to Figure 85 .....	26
Change to Figure 86 .....	27
Updated Outline Dimensions .....	29
Changes to Ordering Guide.....	30

**10/15—Revision 0: Initial Version**

## SPECIFICATIONS

ELECTRICAL CHARACTERISTICS,  $V_{SY} = \pm 15\text{ V}$ 

Supply voltage ( $V_{SY}$ ) =  $\pm 15\text{ V}$ , common-mode voltage ( $V_{CM}$ ) = output voltage ( $V_{OUT}$ ) =  $0\text{ V}$ ,  $T_A = 25^\circ\text{C}$ , unless otherwise noted.

Table 1.

Parameter	Symbol	Test Conditions/Comments	Min	Typ	Max	Unit			
INPUT CHARACTERISTICS									
Offset Voltage	$V_{OS}$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$		0.04	$\pm 0.8$	mV			
A Grade					$\pm 2$	mV			
B Grade				0.04	$\pm 0.35$	mV			
Offset Voltage Match					$\pm 0.8$	mV			
Offset Voltage Drift	$\Delta V_{OS}/\Delta T$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$			$\pm 1$	mV			
A Grade					$\pm 2$	$\pm 15$	$\mu\text{V}/^\circ\text{C}$		
B Grade				$\pm 2$	$\pm 5$	$\mu\text{V}/^\circ\text{C}$			
Input Bias Current	$I_B$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$		2	$\pm 10$	pA			
					$\pm 1.5$	nA			
Input Offset Current	$I_{OS}$	$V_{CM} = V^-$			$-15$	pA			
					$\pm 10$	pA			
Input Voltage Range	IVR		(V-) - 0.2		(V+) - 1	V			
Common-Mode Rejection Ratio	CMRR	$V_{CM} = V^-$ to $(V+) - 3\text{ V}$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$	84	100	dB			
A Grade						81	dB		
B Grade		$V_{CM} = V^-$ to $(V+) - 3\text{ V}$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$	87	100	dB			
				85		dB			
Large Signal Voltage Gain	$A_{VO}$	$R_L = 10\text{ k}\Omega$ , $V_{OUT} = -14.5\text{ V}$ to $+14.5\text{ V}$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$	117	122	dB			
				109		dB			
				102	110	dB			
		$R_L = 1\text{ k}\Omega$ , $V_{OUT} = -14\text{ V}$ to $+14\text{ V}$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$	93		dB			
Input Capacitance	$C_{INDM}$	Differential mode		0.4		pF			
	$C_{INCM}$	Common mode		3.6		pF			
Input Resistance	$R_{DIFF}$	Differential mode		$10^{13}$		$\Omega$			
	$R_{CM}$	Common mode		$10^{13}$		$\Omega$			
OUTPUT CHARACTERISTICS									
Output Voltage	$V_{OH}$	$I_{SOURCE} = 1\text{ mA}$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$	50	30	mV			
High				100		mV			
				700	500	mV			
				900		mV			
Low	$V_{OL}$	$I_{SINK} = 1\text{ mA}$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$		45	65	mV		
							120	mV	
					$I_{SINK} = 15\text{ mA}$		315	450	mV
					$-40^\circ\text{C} < T_A < +125^\circ\text{C}$			750	mV
Output Current	$I_{OUT}$	$V_{DROPOUT} < 1\text{ V}$		20		mA			
Short-Circuit Current	$I_{SC}$	Sourcing		42		mA			
		Sinking		-51		mA			
Closed-Loop Output Impedance	$Z_{OUT}$	$f = 1\text{ kHz}$ , gain ( $A_V$ ) = 1		0.1		$\Omega$			
		$A_V = 10$		0.4		$\Omega$			
		$A_V = 100$		3		$\Omega$			

Parameter	Symbol	Test Conditions/Comments	Min	Typ	Max	Unit
<b>POWER SUPPLY</b>						
Power Supply Rejection Ratio	PSRR	$V_{SY} = \pm 4\text{ V to } \pm 18\text{ V}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$	87	103		dB
Supply Current per Amplifier	$I_{SY}$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$	81	665	700 725	dB $\mu\text{A}$ $\mu\text{A}$
<b>DYNAMIC PERFORMANCE</b>						
Slew Rate	SR	$V_{OUT} = \pm 12.5\text{ V}$ , $R_L = 2\text{ k}\Omega$ , load capacitor ( $C_L$ ) = 100 pF, $A_V = 1$ Low to high transition High to low transition		23 -18		$\text{V}/\mu\text{s}$ $\text{V}/\mu\text{s}$
Gain Bandwidth Product	GBP	$A_V = 100$		8		MHz
Unity-Gain Crossover	UGC	$A_V = 1$		7		MHz
-3 dB Bandwidth	-3 dB	$A_V = 1$		15.5		MHz
Phase Margin	$\Phi_M$			53		Degrees
Settling Time to 0.1%	$t_s$	$V_{IN} = 10\text{ V step}$ , $R_L = 2\text{ k}\Omega$ , $C_L = 15\text{ pF}$ , $A_V = -1$		1.5		$\mu\text{s}$
Settling Time to 0.01%	$t_s$	$V_{IN} = 10\text{ V step}$ , $R_L = 2\text{ k}\Omega$ , $C_L = 15\text{ pF}$ , $A_V = -1$		2		$\mu\text{s}$
<b>EMI REJECTION RATIO</b>						
$f = 1000\text{ MHz}$	EMIRR	$V_{IN} = 100\text{ mV p-p}$		90		dB
$f = 2400\text{ MHz}$				90		dB
<b>NOISE PERFORMANCE</b>						
Voltage Noise	$e_N\text{ p-p}$	0.1 Hz to 10 Hz		0.75		$\mu\text{V p-p}$
Voltage Noise Density	$e_N$	$f = 10\text{ Hz}$ $f = 100\text{ Hz}$ $f = 1\text{ kHz}$ $f = 10\text{ kHz}$		30 15 12.5 12		$\text{nV}/\sqrt{\text{Hz}}$ $\text{nV}/\sqrt{\text{Hz}}$ $\text{nV}/\sqrt{\text{Hz}}$ $\text{nV}/\sqrt{\text{Hz}}$
Current Noise Density	$i_N$	$f = 1\text{ kHz}$		0.8		$\text{fA}/\sqrt{\text{Hz}}$
Total Harmonic Distortion + Noise	THD + N	$A_V = 1$ , $f = 10\text{ Hz to } 20\text{ kHz}$ , input voltage ( $V_{IN}$ ) = 7 V rms at 1 kHz				
Bandwidth (BW) = 80 kHz				0.0003		%
BW = 500 kHz				0.00035		%
<b>MATCHING SPECIFICATIONS</b>						
Maximum Offset Voltage over Temperature				0.5		mV
Offset Voltage Temperature Drift				2.5		$\mu\text{V}/^\circ\text{C}$
Input Bias Current				0.5	5	pA
<b>CROSSTALK</b>						
	$C_S$	$R_L = 5\text{ k}\Omega$ , $V_{IN} = 20\text{ V p-p}$ $f = 1\text{ kHz}$ $f = 100\text{ kHz}$		-112 -72		dB dB

**ELECTRICAL CHARACTERISTICS,  $V_{SY} = \pm 5\text{ V}$**  $V_{SY} = \pm 5\text{ V}$ ,  $V_{CM} = V_{OUT} = 0\text{ V}$ ,  $T_A = 25^\circ\text{C}$ , unless otherwise noted.**Table 2.**

Parameter	Symbol	Test Conditions/Comments	Min	Typ	Max	Unit				
<b>INPUT CHARACTERISTICS</b>										
Offset Voltage	$V_{OS}$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$		0.04	$\pm 0.8$	mV				
A Grade					$\pm 2$	mV				
B Grade				0.04	$\pm 0.35$	mV				
Offset Voltage Match					$\pm 0.8$	mV				
Offset Voltage Drift	$\Delta V_{OS}/\Delta T$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$			$\pm 1$	mV				
A Grade					$\pm 2$	$\pm 15$	$\mu\text{V}/^\circ\text{C}$			
B Grade					$\pm 5$	$\mu\text{V}/^\circ\text{C}$				
Input Bias Current	$I_B$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$		2	$\pm 10$	pA				
					$\pm 1.5$	nA				
Input Offset Current	$I_{OS}$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$			$-5$	pA				
					$\pm 10$	pA				
Input Voltage Range	IVR				$(V-) - 0.2$	V				
Common-Mode Rejection Ratio	CMRR	$V_{CM} = V- \text{ to } (V+) - 3\text{ V}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$		75	91	dB				
A Grade							73	dB		
B Grade							78	91	dB	
							75	dB		
Large Signal Voltage Gain	$A_{VO}$	$R_L = 10\text{ k}\Omega$ , $V_{OUT} = -4.4\text{ V to } +4.4\text{ V}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$		113	118	dB				
							105	dB		
							100	105	dB	
							91	dB		
Input Capacitance	$C_{INDM}$	Differential mode			0.4	pF				
	$C_{INCM}$	Common mode			3.6	pF				
Input Resistance	$R_{DIFF}$	Differential mode			$10^{13}$	$\Omega$				
	$R_{CM}$	Common mode			$10^{13}$	$\Omega$				
<b>OUTPUT CHARACTERISTICS</b>										
Output Voltage	$V_{OH}$	$I_{SOURCE} = 1\text{ mA}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$		50	30	mV				
High							100	mV		
							700	490	mV	
							900	mV		
Low	$V_{OL}$	$I_{SINK} = 1\text{ mA}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$			45	65	mV			
								120	mV	
								315	450	mV
								750	mV	
Output Current	$I_{OUT}$	$V_{DROPOUT} < 1\text{ V}$			20	mA				
Short-Circuit Current	$I_{SC}$	Sourcing			31	mA				
		Sinking			-40	mA				
Closed-Loop Output Impedance	$Z_{OUT}$	$f = 1\text{ kHz}$ , $A_V = 1$			0.1	$\Omega$				
					$A_V = 10$	0.4	$\Omega$			
					$A_V = 100$	4	$\Omega$			

Parameter	Symbol	Test Conditions/Comments	Min	Typ	Max	Unit
<b>POWER SUPPLY</b>						
Power Supply Rejection Ratio	PSRR	$V_{SY} = \pm 4\text{ V to } \pm 18\text{ V}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$	87	103		dB
Supply Current per Amplifier	$I_{SY}$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$	81	610	675 700	dB $\mu\text{A}$ $\mu\text{A}$
<b>DYNAMIC PERFORMANCE</b>						
Slew Rate	SR	$V_{OUT} = \pm 3\text{ V}$ , $R_L = 2\text{ k}\Omega$ , $C_L = 100\text{ pF}$ , $A_V = 1$ Low to high transition High to low transition		21 -16		$\text{V}/\mu\text{s}$ $\text{V}/\mu\text{s}$
Gain Bandwidth Product	GBP	$A_V = 100$		7.8		MHz
Unity-Gain Crossover	UGC	$A_V = 1$		6.5		MHz
-3 dB Bandwidth	-3 dB	$A_V = 1$		10		MHz
Phase Margin	$\Phi_M$			50		Degrees
Settling Time to 0.1%	$t_s$	$V_{IN} = 8\text{ V step}$ , $R_L = 2\text{ k}\Omega$ , $C_L = 15\text{ pF}$ , $A_V = -1$		1.5		$\mu\text{s}$
Settling Time to 0.01%	$t_s$	$V_{IN} = 8\text{ V step}$ , $R_L = 2\text{ k}\Omega$ , $C_L = 15\text{ pF}$ , $A_V = -1$		2		$\mu\text{s}$
<b>EMI REJECTION RATIO</b>						
f = 1000 MHz	EMIRR	$V_{IN} = 100\text{ mV p-p}$		90		dB
f = 2400 MHz				90		dB
<b>NOISE PERFORMANCE</b>						
Voltage Noise	$e_N\text{ p-p}$	0.1 Hz to 10 Hz		0.75		$\mu\text{V p-p}$
Voltage Noise Density	$e_N$	f = 10 Hz f = 100 Hz f = 1 kHz f = 10 kHz		30 15 12.5 12		$\text{nV}/\sqrt{\text{Hz}}$ $\text{nV}/\sqrt{\text{Hz}}$ $\text{nV}/\sqrt{\text{Hz}}$ $\text{nV}/\sqrt{\text{Hz}}$
Current Noise Density	$i_N$	f = 1 kHz		0.8		$\text{pA}/\sqrt{\text{Hz}}$
Total Harmonic Distortion + Noise	THD + N	$A_V = 1$ , f = 10 Hz to 20 kHz, $V_{IN} = 1.5\text{ V rms}$ at 1 kHz		0.0005 0.0008		% %
<b>MATCHING SPECIFICATIONS</b>						
Maximum Offset Voltage over Temperature				0.5		mV
Offset Voltage Temperature Drift				2.5		$\mu\text{V}/^\circ\text{C}$
Input Bias Current				0.5	5	pA
<b>CROSSTALK</b>						
	$C_s$	$R_L = 5\text{ k}\Omega$ , $V_{IN} = 6\text{ V p-p}$ f = 1 kHz f = 100 kHz		-112 -72		dB dB

**ELECTRICAL CHARACTERISTICS,  $V_{SY} = 5\text{ V}$**  $V_{SY} = 5\text{ V}$ ,  $V_{CM} = 0\text{ V}$ ,  $V_{OUT} = V_{SY}/2$ ,  $T_A = 25^\circ\text{C}$ , unless otherwise noted.

Table 3.

Parameter	Symbol	Test Conditions/Comments	Min	Typ	Max	Unit
<b>INPUT CHARACTERISTICS</b>						
Offset Voltage	$V_{OS}$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$		0.04	$\pm 0.8$	mV
A Grade					$\pm 2$	mV
B Grade				0.04	$\pm 0.35$	mV
Offset Voltage Match					$\pm 0.8$	mV
Offset Voltage Drift	$\Delta V_{OS}/\Delta T$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$			$\pm 1$	mV
A Grade					$\pm 2$	$\pm 15$
B Grade				$\pm 2$	$\pm 5$	$\mu\text{V}/^\circ\text{C}$
Input Bias Current	$I_B$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$		2	$\pm 10$	$\mu\text{A}$
Input Offset Current	$I_{OS}$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$			$\pm 1.5$	nA
Input Voltage Range	IVR		(V-) - 0.2		(V+) - 1	V
Common-Mode Rejection Ratio	CMRR	$V_{CM} = V_- \text{ to } (V_+) - 3\text{ V}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$	70	87		dB
A Grade						
B Grade		$V_{CM} = V_- \text{ to } (V_+) - 3\text{ V}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$	73	87		dB
Large Signal Voltage Gain	$A_{VO}$	$R_L = 10\text{ k}\Omega \text{ to } V_-, V_{OUT} = 0.2\text{ V to } 4.6\text{ V}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$	110	115		dB
			99			dB
			$R_L = 1\text{ k}\Omega \text{ to } V_-, V_{OUT} = 0.2\text{ V to } 4.6\text{ V}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$	96	104	
			87			dB
Input Capacitance	$C_{INDM}$	Differential mode		0.4		pF
	$C_{INCM}$	Common mode		3.6		pF
Input Resistance	$R_{DIFF}$	Differential mode		$10^{13}$		$\Omega$
	$R_{CM}$	Common mode		$10^{13}$		$\Omega$
<b>OUTPUT CHARACTERISTICS</b>						
Output Voltage	$V_{OH}$	$I_{SOURCE} = 1\text{ mA}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$	50	30		mV
High			100			mV
	$V_{OL}$	$I_{SOURCE} = 15\text{ mA}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$	700	500		mV
Low			900			mV
		$I_{SINK} = 1\text{ mA}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$		45	65	mV
						120
		$I_{SINK} = 15\text{ mA}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$		310	450	mV
						750
Output Current	$I_{OUT}$	$V_{DROPOUT} < 1\text{ V}$		20		mA
Short-Circuit Current	$I_{SC}$	Sourcing		27		mA
		Sinking		-35		mA
Closed-Loop Output Impedance	$Z_{OUT}$	$f = 1\text{ kHz}, A_V = 1$		0.1		$\Omega$
		$A_V = 10$		0.6		$\Omega$
		$A_V = 100$		5		$\Omega$
<b>POWER SUPPLY</b>						
Power Supply Rejection Ratio	PSRR	$V_{SY} = 4\text{ V to } 15\text{ V}$ $-40^\circ\text{C} < T_A < +125^\circ\text{C}$	80	95		dB
			74			dB
Supply Current per Amplifier	$I_{SY}$	$-40^\circ\text{C} < T_A < +125^\circ\text{C}$		600	650	$\mu\text{A}$
					675	$\mu\text{A}$

Parameter	Symbol	Test Conditions/Comments	Min	Typ	Max	Unit
<b>DYNAMIC PERFORMANCE</b>						
Slew Rate	SR	$V_{OUT} = 0.5\text{ V to }3.5\text{ V}$ , $R_L = 2\text{ k}\Omega$ , $C_L = 100\text{ pF}$ , $A_V = 1$ Low to high transition High to low transition		20 -15		$\text{V}/\mu\text{s}$ $\text{V}/\mu\text{s}$
Gain Bandwidth Product	GBP	$A_V = 100$		7.2		MHz
Unity-Gain Crossover	UGC	$A_V = 1$		6		MHz
-3 dB Bandwidth	-3 dB	$A_V = 1$		9		MHz
Phase Margin	$\Phi_M$			50		Degrees
Settling Time to 0.1%	$t_s$	$V_{IN} = 4\text{ V step}$ , $R_L = 2\text{ k}\Omega$ , $C_L = 15\text{ pF}$ , $A_V = -1$		1.5		$\mu\text{s}$
Settling Time to 0.01%	$t_s$	$V_{IN} = 4\text{ V step}$ , $R_L = 2\text{ k}\Omega$ , $C_L = 15\text{ pF}$ , $A_V = -1$		2.0		$\mu\text{s}$
<b>EMI REJECTION RATIO</b>						
$f = 1000\text{ MHz}$	EMIRR	$V_{IN} = 100\text{ mV p-p}$		90		dB
$f = 2400\text{ MHz}$				90		dB
<b>NOISE PERFORMANCE</b>						
Voltage Noise	$e_N\text{ p-p}$	0.1 Hz to 10 Hz		0.75		$\mu\text{V p-p}$
Voltage Noise Density	$e_N$	$f = 10\text{ Hz}$		30		$\text{nV}/\sqrt{\text{Hz}}$
		$f = 100\text{ Hz}$		15		$\text{nV}/\sqrt{\text{Hz}}$
		$f = 1\text{ kHz}$		12.5		$\text{nV}/\sqrt{\text{Hz}}$
		$f = 10\text{ kHz}$		12		$\text{nV}/\sqrt{\text{Hz}}$
		$f = 1\text{ kHz}$		0.8		$\text{pA}/\sqrt{\text{Hz}}$
Current Noise Density	$i_N$	$f = 1\text{ kHz}$		0.8		$\text{pA}/\sqrt{\text{Hz}}$
Total Harmonic Distortion + Noise	THD + N	$A_V = 1$ , $f = 10\text{ Hz to }20\text{ kHz}$ , $V_{IN} = 0.5\text{ V rms at }1\text{ kHz}$		0.0025		%
				0.0025		%
<b>MATCHING SPECIFICATIONS</b>						
Maximum Offset Voltage over Temperature				0.5		mV
Offset Voltage Temperature Drift				2.5		$\mu\text{V}/^\circ\text{C}$
Input Bias Current				0.5	5	pA
<b>CROSSTALK</b>						
	$C_S$	$R_L = 5\text{ k}\Omega$ , $V_{IN} = 3\text{ V p-p}$		-112		dB
		$f = 1\text{ kHz}$		-72		dB
		$f = 100\text{ kHz}$				



## ABSOLUTE MAXIMUM RATINGS

Table 4.

Parameter	Rating
Supply Voltage	36 V
Input Voltage	(V-) – 0.3 V to (V+) + 0.2 V
Differential Input Voltage	36 V
Storage Temperature Range	–65°C to +150°C
Operating Temperature Range	–40°C to +125°C
Junction Temperature Range	–65°C to +150°C
Lead Temperature, Soldering (10 sec)	300°C
ESD Rating, Human Body Model (HBM)	4 kV

Stresses at or above those listed under Absolute Maximum Ratings may cause permanent damage to the product. This is a stress rating only; functional operation of the product at these or any other conditions above those indicated in the operational section of this specification is not implied. Operation beyond the maximum operating conditions for extended periods may affect product reliability.

## THERMAL RESISTANCE

Thermal performance is directly linked to printed circuit board (PCB) design and operating environment. Close attention to PCB thermal design is required.

Table 5. Thermal Resistance<sup>1</sup>

Package Type	$\theta_{JA}$	Unit
8-Lead SOIC		
1-Layer JEDEC Board	180	°C/W
2-Layer JEDEC Board	120	°C/W
8-Lead MSOP		
1-Layer JEDEC Board	265	°C/W
2-Layer JEDEC Board	185	°C/W
8-Lead LFCSP		
1-Layer JEDEC Board	272	°C/W
2-Layer JEDEC Board	145	°C/W
2-Layer JEDEC Board with 2 × 2 Vias	55	°C/W

<sup>1</sup> Thermal impedance simulated values are based on a JEDEC thermal test board. See JEDEC JESD51.

## ESD CAUTION



**ESD (electrostatic discharge) sensitive device.** Charged devices and circuit boards can discharge without detection. Although this product features patented or proprietary protection circuitry, damage may occur on devices subjected to high energy ESD. Therefore, proper ESD precautions should be taken to avoid performance degradation or loss of functionality.

## PIN CONFIGURATIONS AND FUNCTION DESCRIPTIONS

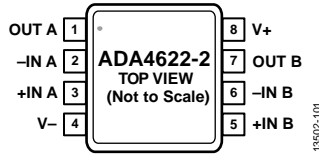


Figure 2. 8-Lead MSOP Pin Configuration

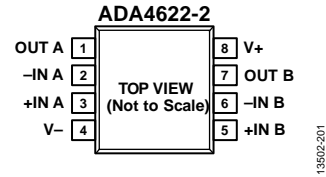
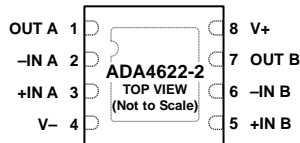


Figure 3. 8-Lead SOIC Pin Configuration

Table 6. 8-Lead SOIC and 8-Lead MSOP Pin Function Descriptions

Pin No.	Mnemonic	Description
1	OUT A	Output, Channel A
2	-IN A	Inverting Input, Channel A
3	+IN A	Noninverting Input, Channel A
4	V-	Negative Supply Voltage
5	+IN B	Noninverting Input, Channel B
6	-IN B	Inverting Input, Channel B
7	OUT B	Output, Channel B
8	V+	Positive Supply Voltage



**NOTES**  
 1. IT IS RECOMMENDED TO CONNECT THE EXPOSED PAD TO THE V+ PIN.

Figure 4. 8-Lead LFCSP Pin Configuration

Table 7. 8-Lead LFCSP Pin Function Descriptions

Pin No.	Mnemonic	Description
1	OUT A	Output, Channel A.
2	-IN A	Inverting Input, Channel A.
3	+IN A	Noninverting Input, Channel A.
4	V-	Negative Supply Voltage.
5	+IN B	Noninverting Input, Channel B.
6	-IN B	Inverting Input, Channel B.
7	OUT B	Output, Channel B.
8	V+	Positive Supply Voltage.
EPAD	EPAD	Exposed Pad. It is recommended to connect the exposed pad to the V+ pin.

# TYPICAL PERFORMANCE CHARACTERISTICS

T<sub>A</sub> = 25°C, unless otherwise noted.

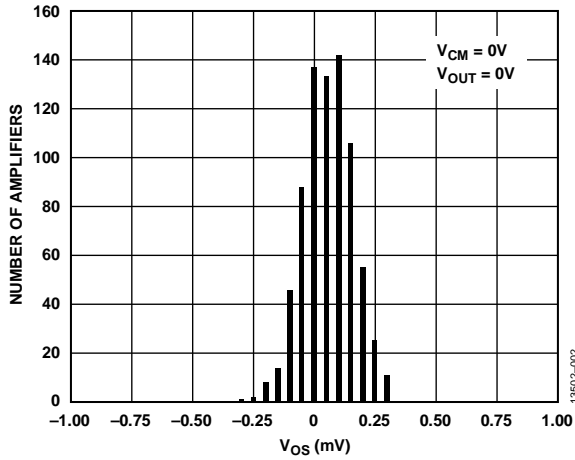


Figure 5. Input Offset Voltage ( $V_{OS}$ ) Distribution,  $V_{SY} = \pm 15 V$

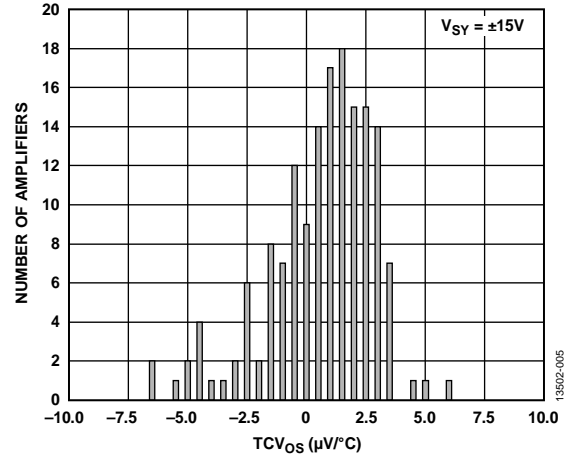


Figure 8. Input Offset Voltage Drift ( $TCV_{OS}$ ) Distribution ( $-40^{\circ}C$  to  $+85^{\circ}C$ ),  $V_{SY} = \pm 15 V$

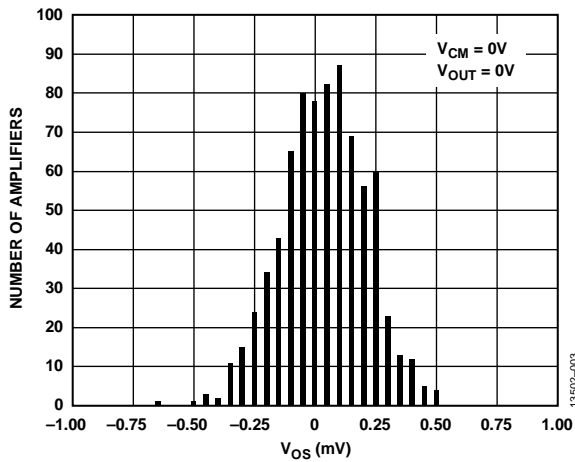


Figure 6. Input Offset Voltage ( $V_{OS}$ ) Distribution,  $V_{SY} = \pm 5 V$

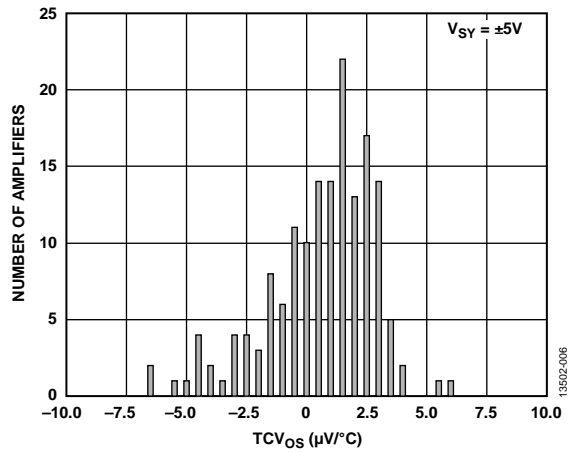


Figure 9. Input Offset Voltage Drift ( $TCV_{OS}$ ) Distribution ( $-40^{\circ}C$  to  $+125^{\circ}C$ ),  $V_{SY} = \pm 5 V$

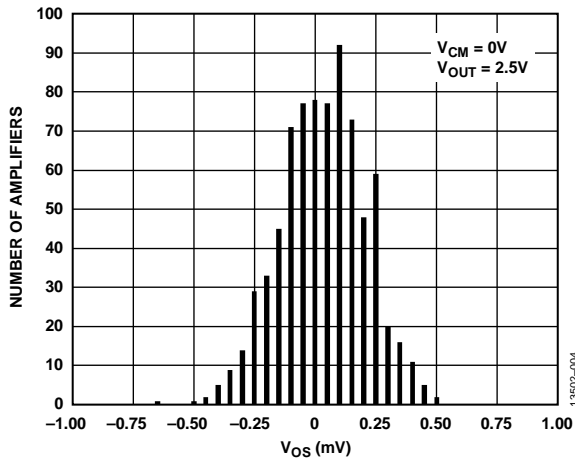


Figure 7. Input Offset Voltage ( $V_{OS}$ ) Distribution,  $V_{SY} = 5 V$

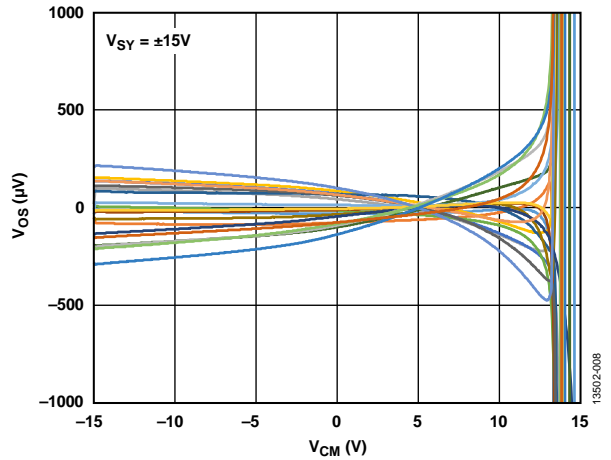


Figure 10. Input Offset Voltage ( $V_{OS}$ ) vs. Common-Mode Voltage ( $V_{CM}$ ),  $V_{SY} = \pm 15 V$

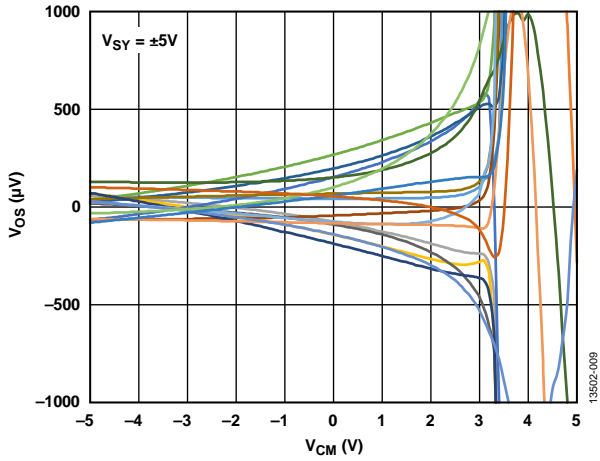


Figure 11. Input Offset Voltage ( $V_{OS}$ ) vs. Common-Mode Voltage ( $V_{CM}$ ),  $V_{SY} = \pm 5V$

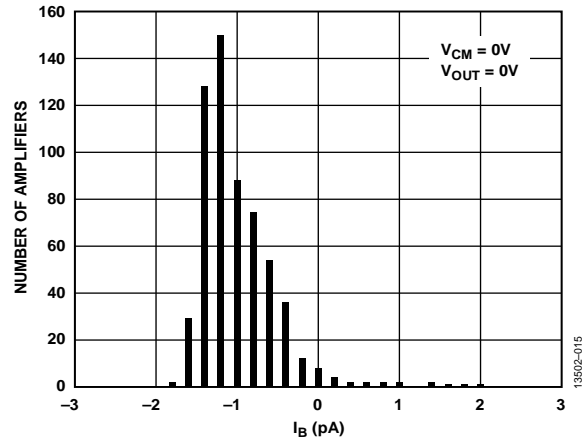


Figure 14. Input Bias Current ( $I_B$ ) Distribution,  $V_{SY} = \pm 5V$

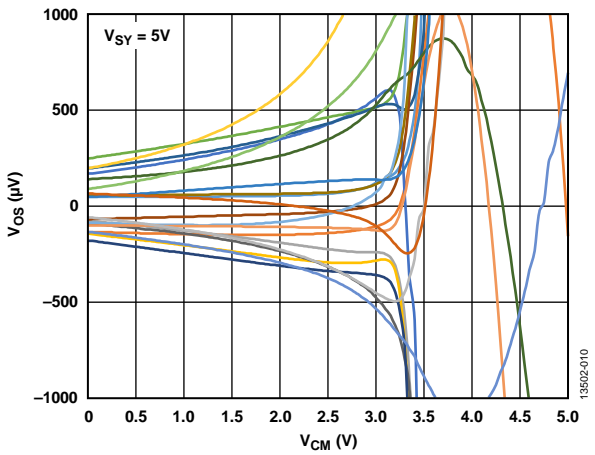


Figure 12. Input Offset Voltage ( $V_{OS}$ ) vs. Common-Mode Voltage ( $V_{CM}$ ),  $V_{SY} = 5V$

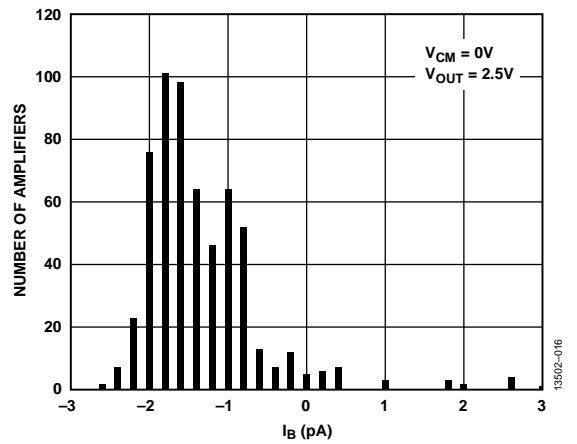


Figure 15. Input Bias Current ( $I_B$ ) Distribution,  $V_{SY} = 5V$

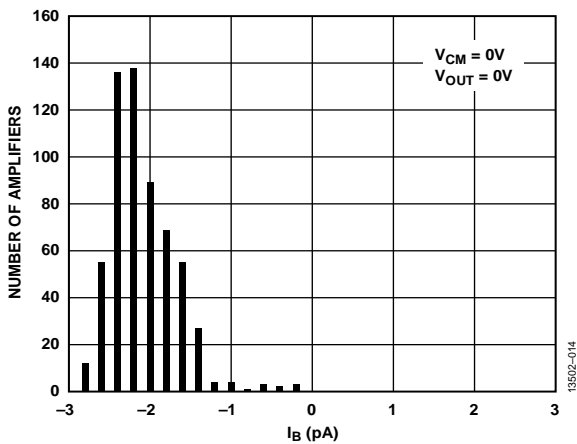


Figure 13. Input Bias Current ( $I_B$ ) Distribution,  $V_{SY} = \pm 15V$

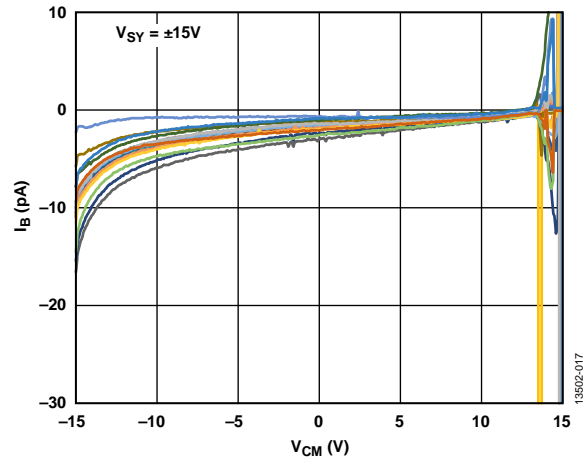


Figure 16. Input Bias Current ( $I_B$ ) vs. Input Common-Mode Voltage ( $V_{CM}$ ),  $V_{SY} = \pm 15V$

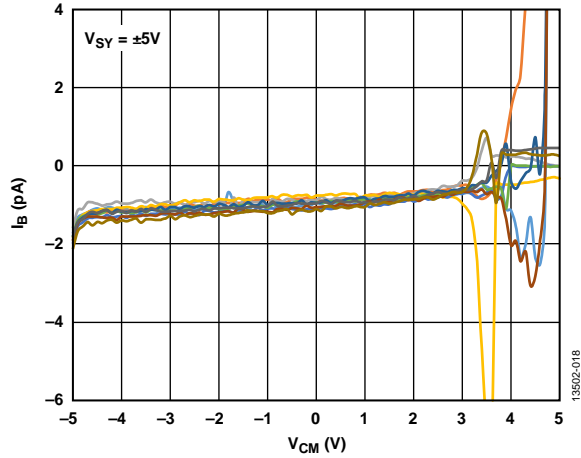


Figure 17. Input Bias Current ( $I_b$ ) vs. Input Common-Mode Voltage ( $V_{CM}$ ),  $V_{SY} = \pm 5 V$

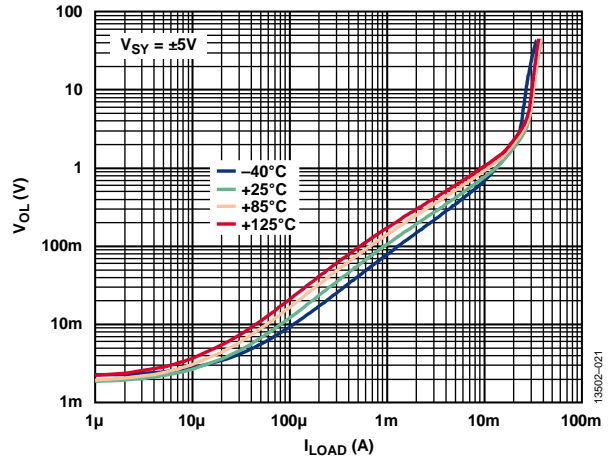


Figure 20. Output Voltage Low ( $V_{OL}$ ) to Supply Rail vs. Load Current ( $I_{LOAD}$ ) over Temperature,  $V_{SY} = \pm 5 V$

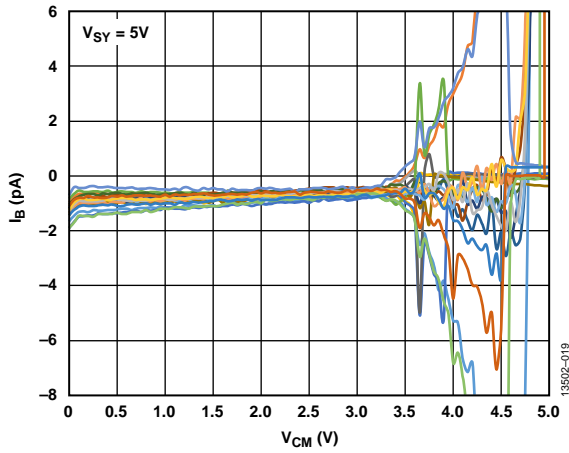


Figure 18. Input Bias Current ( $I_b$ ) vs. Input Common-Mode Voltage ( $V_{CM}$ ),  $V_{SY} = 5 V$

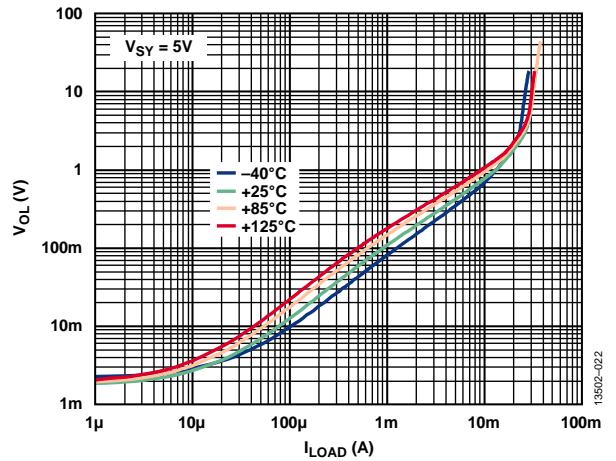


Figure 21. Output Voltage Low ( $V_{OL}$ ) to Supply Rail vs. Load Current ( $I_{LOAD}$ ) over Temperature,  $V_{SY} = 5 V$

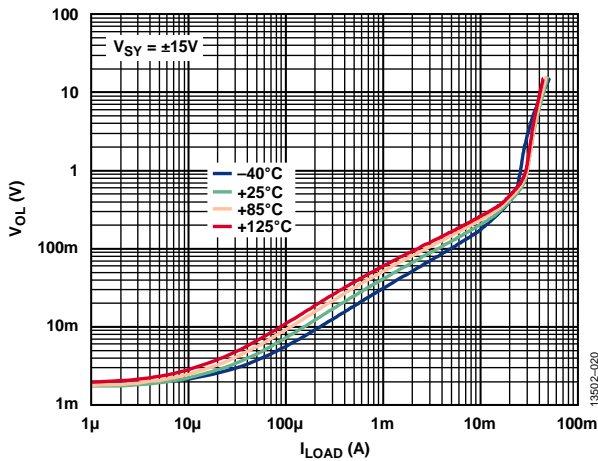


Figure 19. Output Voltage Low ( $V_{OL}$ ) to Supply Rail vs. Load Current ( $I_{LOAD}$ ) over Temperature,  $V_{SY} = \pm 15 V$

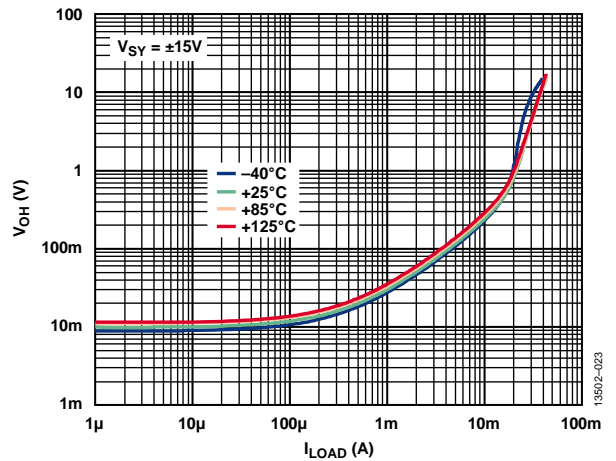


Figure 22. Output Voltage High ( $V_{OH}$ ) to Supply Rail vs. Load Current ( $I_{LOAD}$ ) over Temperature,  $V_{SY} = \pm 15 V$

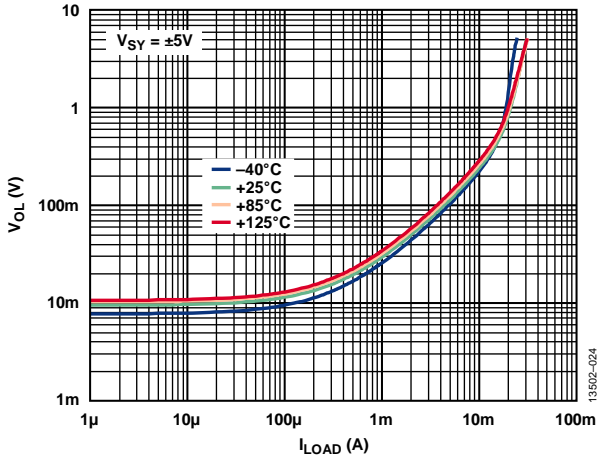


Figure 23. Output Voltage High ( $V_{OH}$ ) to Supply Rail vs. Load Current ( $I_{LOAD}$ ) over Temperature,  $V_{SY} = \pm 5 V$

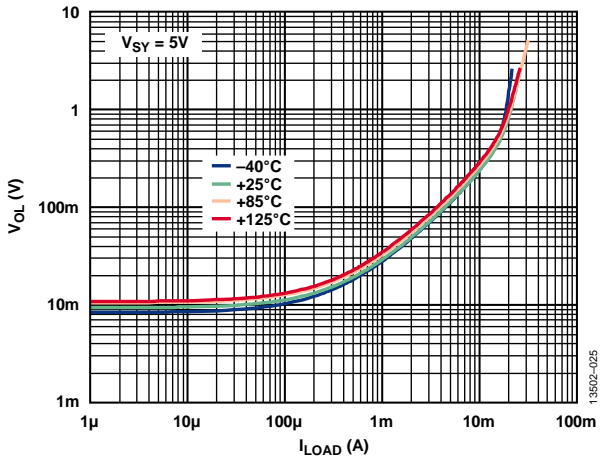


Figure 24. Output Voltage High ( $V_{OH}$ ) to Supply Rail vs. Load Current ( $I_{LOAD}$ ) over Temperature,  $V_{SY} = 5 V$

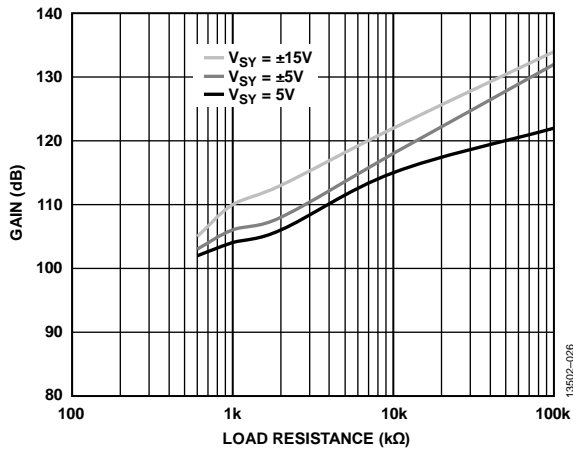


Figure 25. Open-Loop Gain ( $A_{VO}$ ) vs. Load Resistance

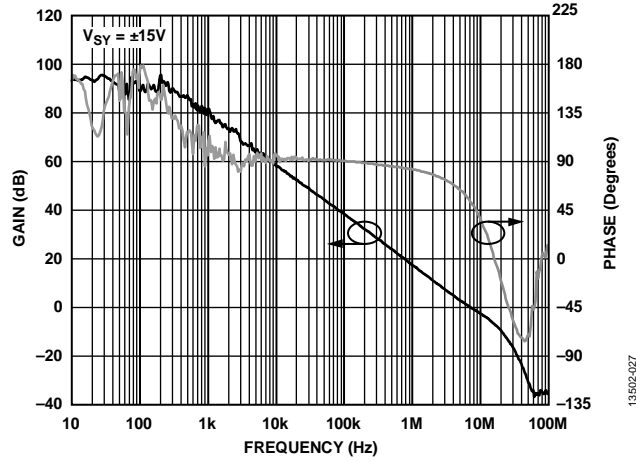


Figure 26. Open-Loop Gain and Phase vs. Frequency,  $V_{SY} = \pm 15 V$

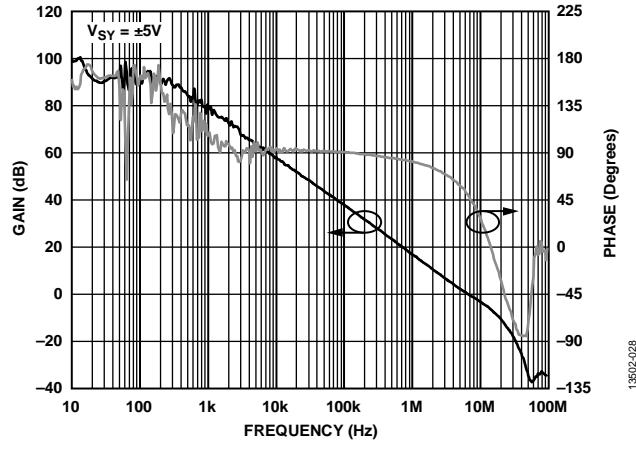


Figure 27. Open-Loop Gain and Phase vs. Frequency,  $V_{SY} = \pm 5 V$

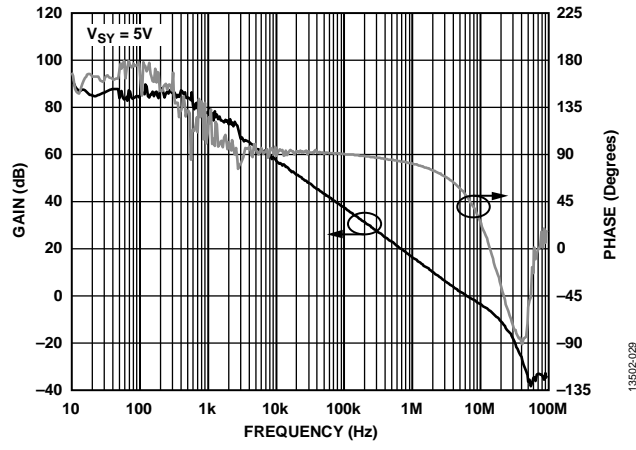


Figure 28. Open-Loop Gain and Phase vs. Frequency,  $V_{SY} = 5 V$

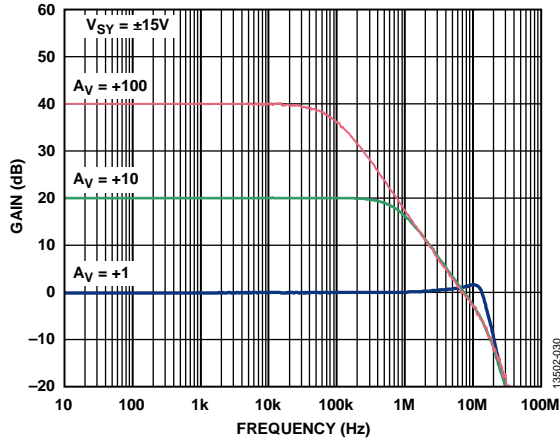


Figure 29. Closed-Loop Gain vs. Frequency,  $V_{SY} = \pm 15 V$

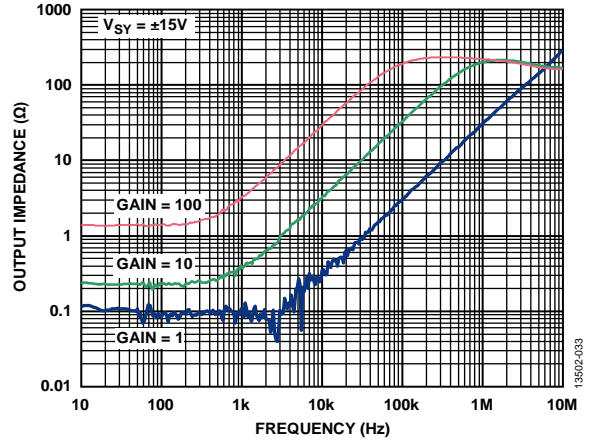


Figure 32. Output Impedance vs. Frequency,  $V_{SY} = \pm 15 V$

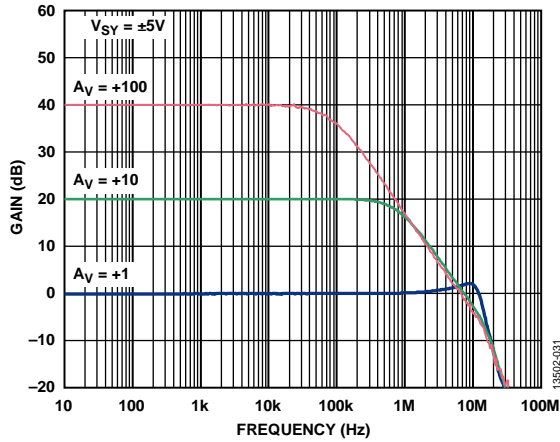


Figure 30. Closed-Loop Gain vs. Frequency,  $V_{SY} = \pm 5 V$

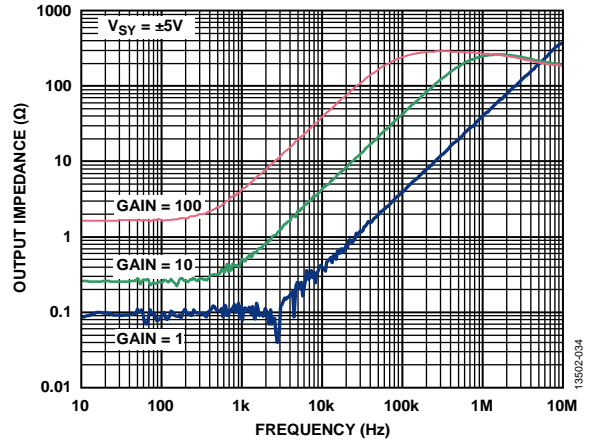


Figure 33. Output Impedance vs. Frequency,  $V_{SY} = \pm 5 V$

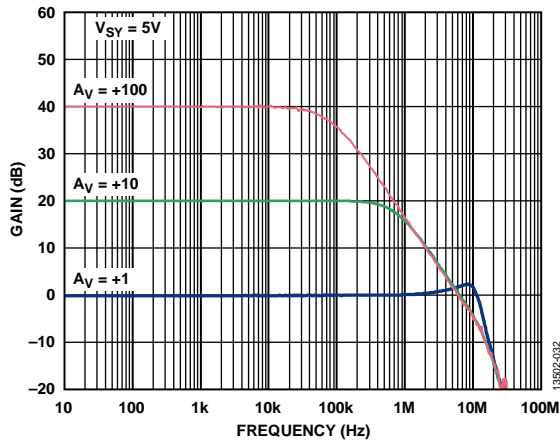


Figure 31. Closed-Loop Gain vs. Frequency,  $V_{SY} = 5 V$

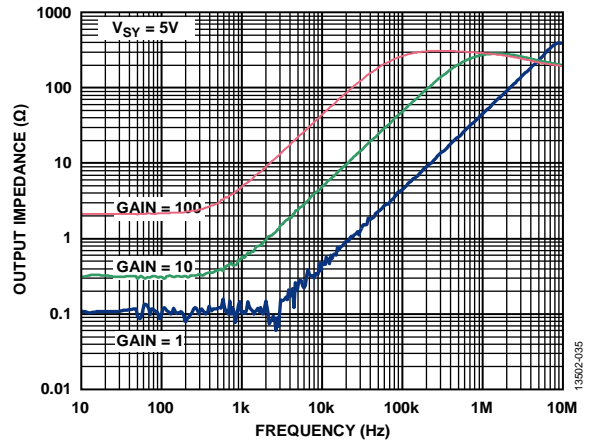


Figure 34. Output Impedance vs. Frequency,  $V_{SY} = 5 V$

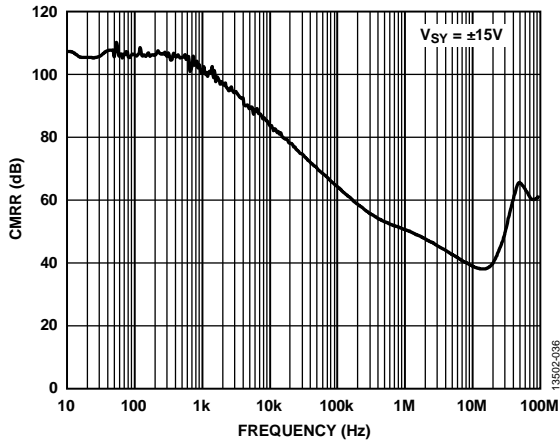


Figure 35. CMRR vs. Frequency,  $V_{SY} = \pm 15V$

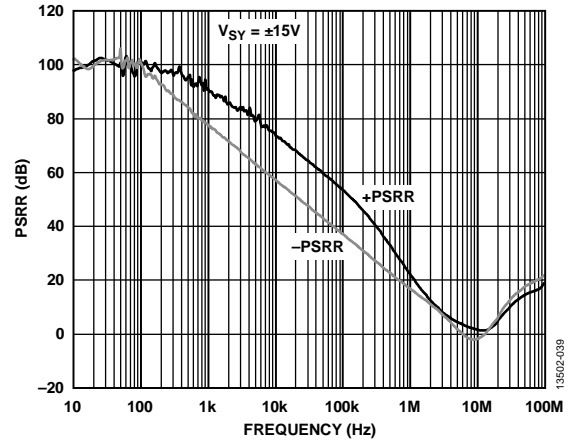


Figure 38. PSRR vs. Frequency,  $V_{SY} = \pm 15V$

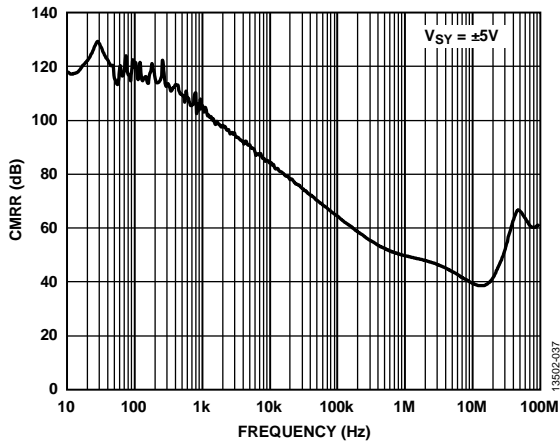


Figure 36. CMRR vs. Frequency,  $V_{SY} = \pm 5V$

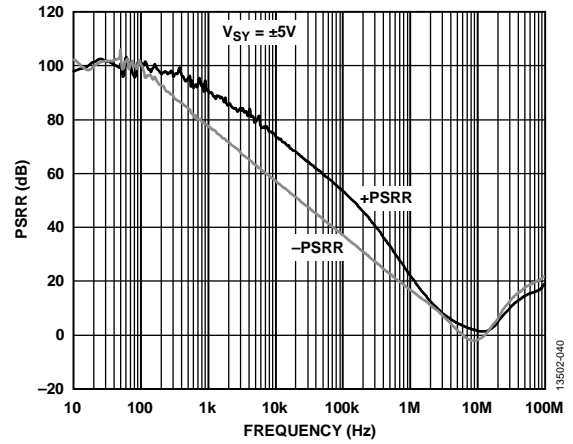


Figure 39. PSRR vs. Frequency,  $V_{SY} = \pm 5V$

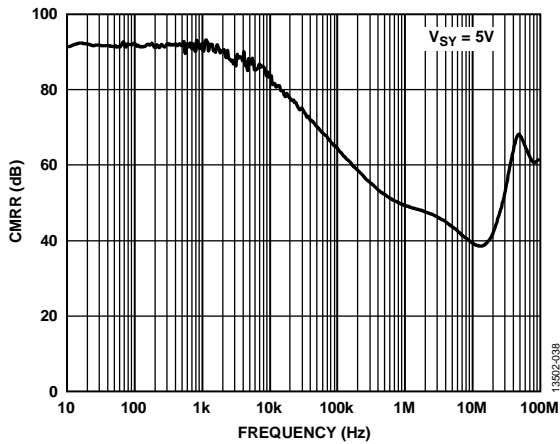


Figure 37. CMRR vs. Frequency,  $V_{SY} = 5V$

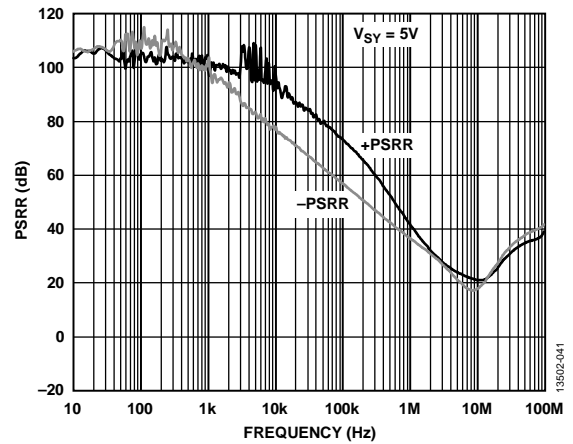


Figure 40. PSRR vs. Frequency,  $V_{SY} = 5V$



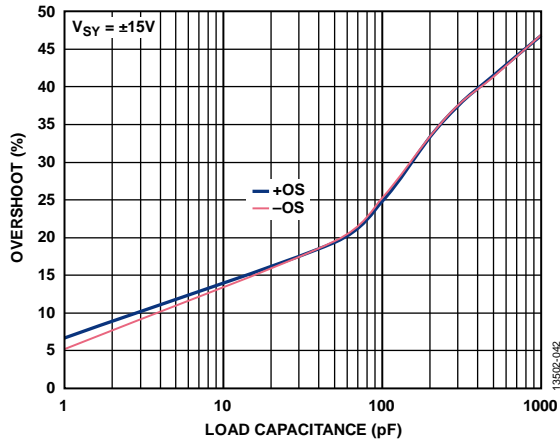


Figure 41. Small Signal Overshoot (OS) vs. Load Capacitance,  $V_{SY} = \pm 15\text{ V}$

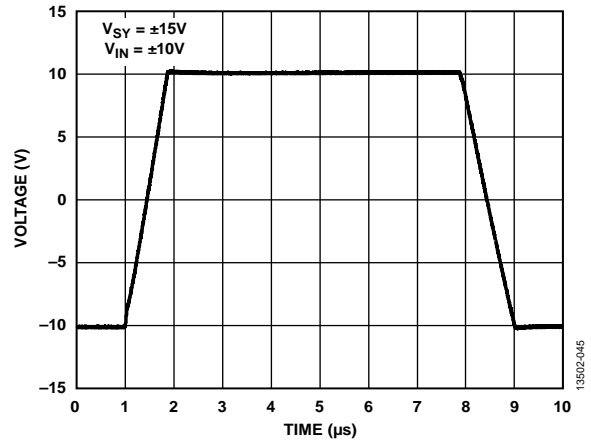


Figure 44. Large Signal Transient Response,  $V_{SY} = \pm 15\text{ V}$

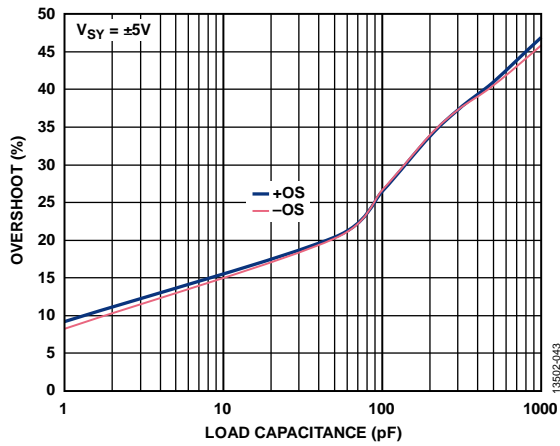


Figure 42. Small Signal Overshoot (OS) vs. Load Capacitance,  $V_{SY} = \pm 5\text{ V}$

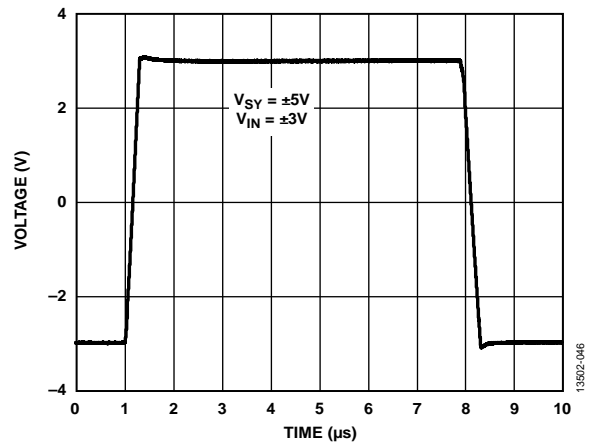


Figure 45. Large Signal Transient Response,  $V_{SY} = \pm 5\text{ V}$

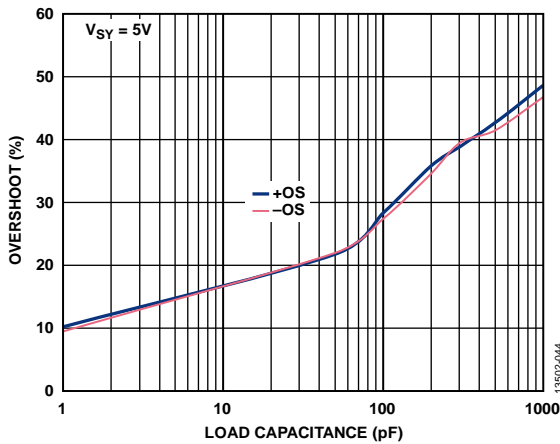


Figure 43. Small Signal Overshoot (OS) vs. Load Capacitance,  $V_{SY} = 5\text{ V}$

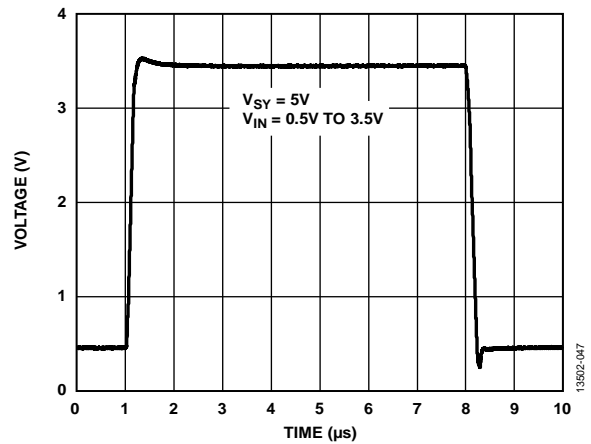


Figure 46. Large Signal Transient Response,  $V_{SY} = 5\text{ V}$

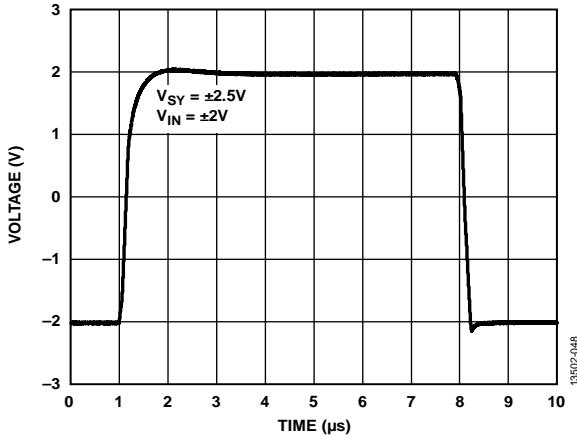


Figure 47. Large Signal Transient Response,  $V_{SV} = \pm 2.5 V$

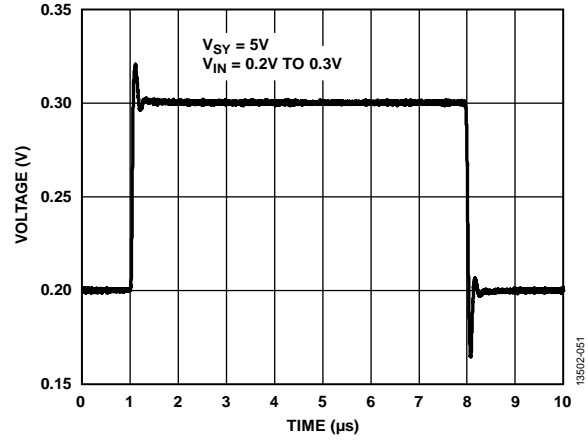


Figure 50. Small Signal Transient Response,  $V_{SV} = 5 V$

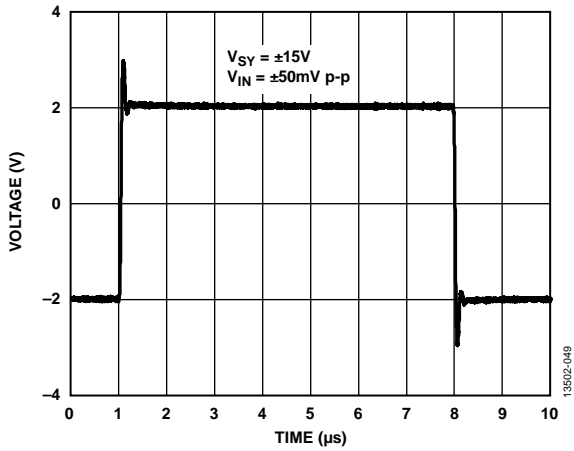


Figure 48. Small Signal Transient Response,  $V_{SV} = \pm 15 V$

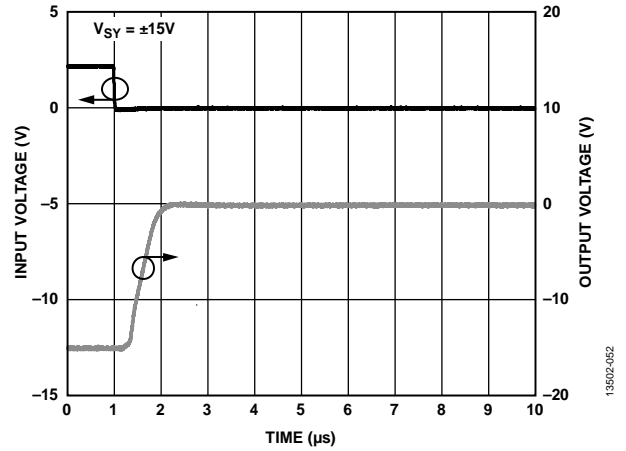


Figure 51. Negative Overload Recovery,  $A_V = -10$ ,  $V_{SV} = \pm 15 V$

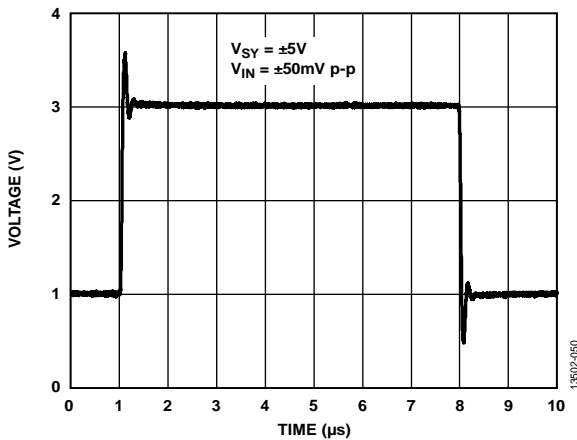


Figure 49. Small Signal Transient Response,  $V_{SV} = \pm 5 V$

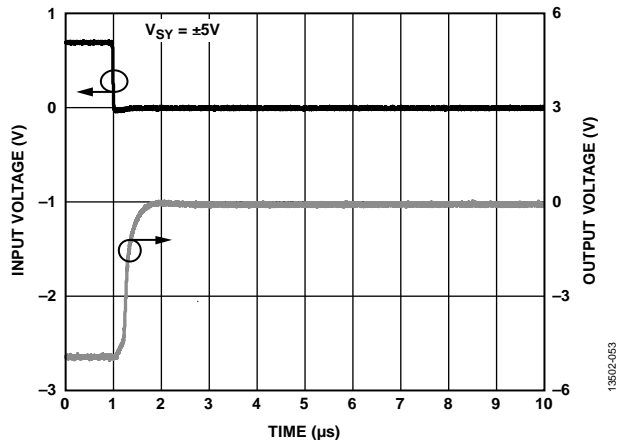


Figure 52. Negative Overload Recovery,  $A_V = -10$ ,  $V_{SV} = \pm 5 V$

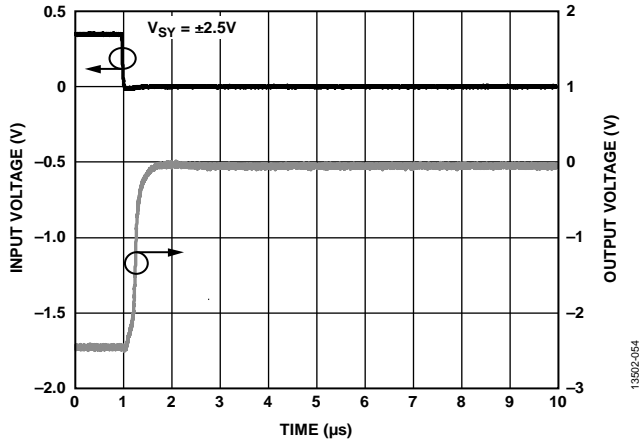


Figure 53. Negative Overload Recovery,  $A_V = -10$ ,  $V_{SY} = \pm 2.5V$

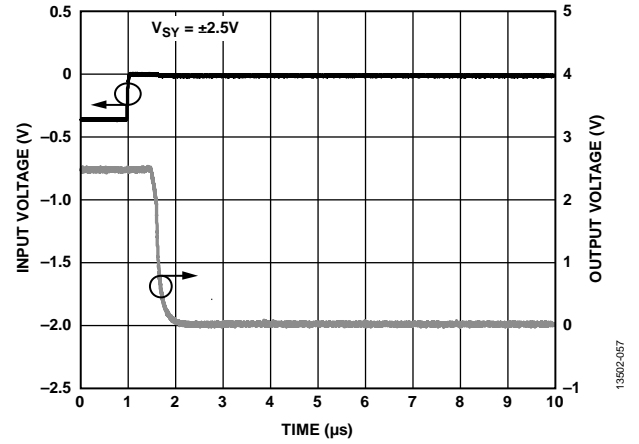


Figure 56. Positive Overload Recovery,  $A_V = -10$ ,  $V_{SY} = \pm 2.5V$

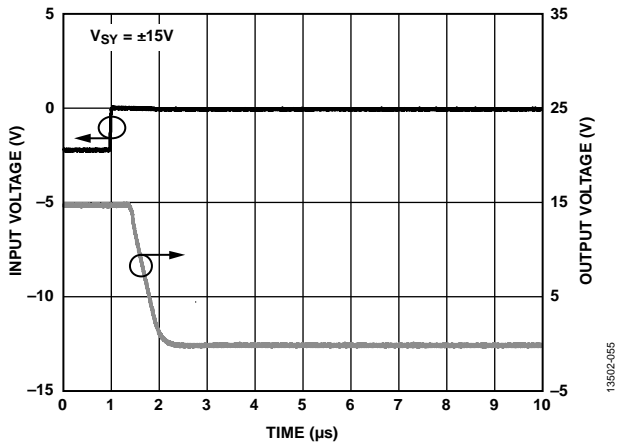


Figure 54. Positive Overload Recovery,  $A_V = -10$ ,  $V_{SY} = \pm 15V$

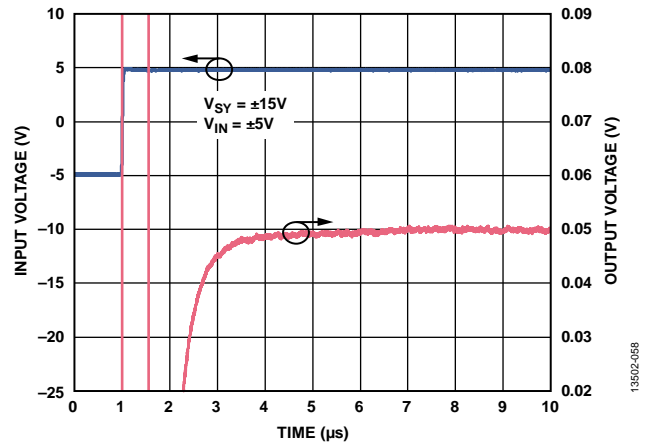


Figure 57. Positive Settling Time,  $A_V = -10$ ,  $V_{SY} = \pm 15V$

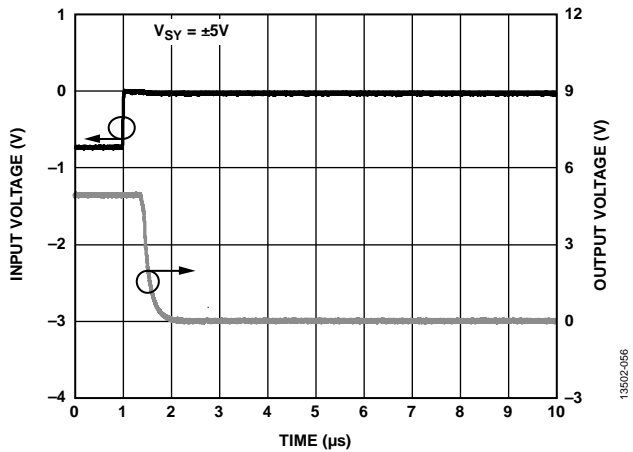


Figure 55. Positive Overload Recovery,  $A_V = -10$ ,  $V_{SY} = \pm 5V$

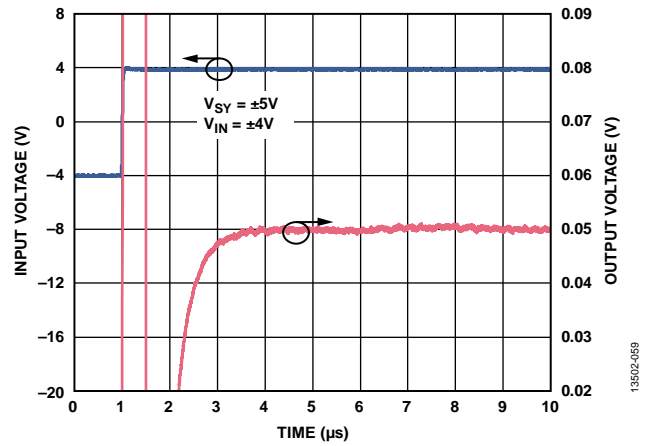


Figure 58. Positive Settling Time,  $A_V = -10$ ,  $V_{SY} = \pm 5V$

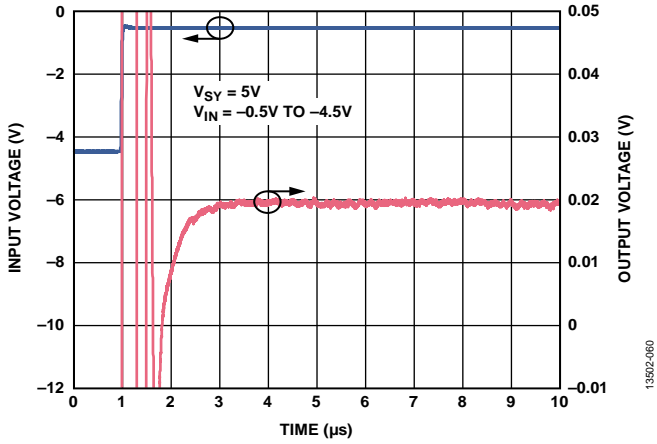


Figure 59. Positive Settling Time,  $A_V = -10$ ,  $V_{SY} = 5\text{ V}$

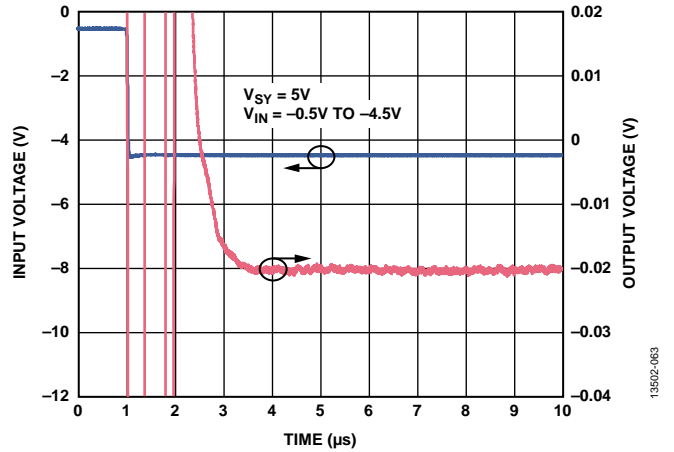


Figure 62. Negative Settling Time,  $A_V = -10$ ,  $V_{SY} = 5\text{ V}$

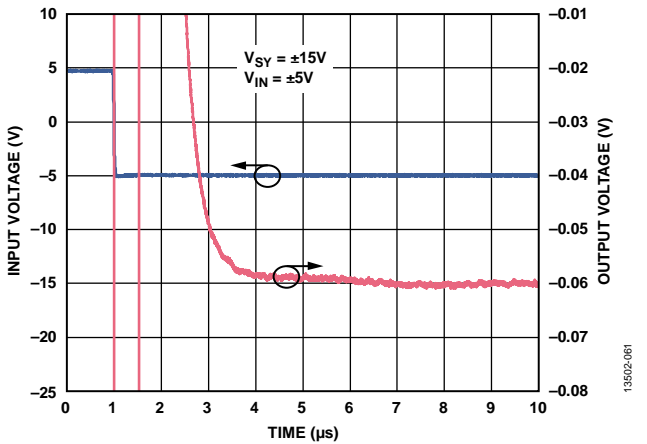


Figure 60. Negative Settling Time,  $A_V = -10$ ,  $V_{SY} = \pm 15\text{ V}$

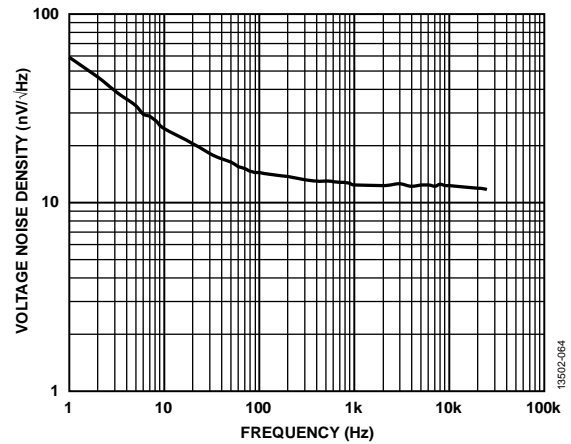


Figure 63. Voltage Noise Density,  $V_{SY} = \pm 15\text{ V}$

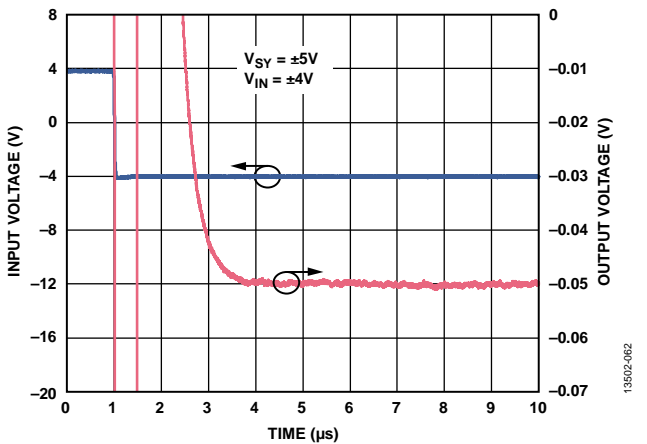


Figure 61. Negative Settling Time,  $A_V = -10$ ,  $V_{SY} = \pm 5\text{ V}$

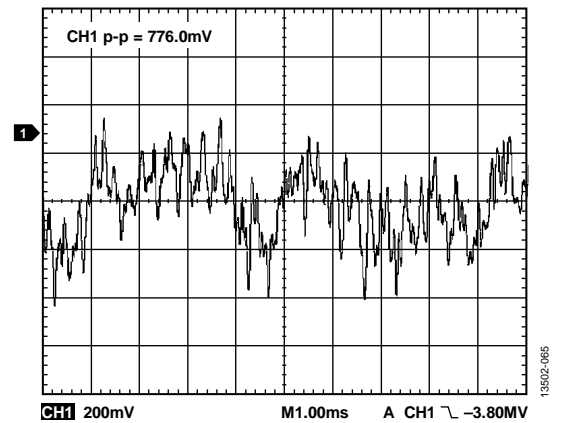


Figure 64. 0.1 Hz to 10 Hz Noise,  $V_{SY} = \pm 15\text{ V}$

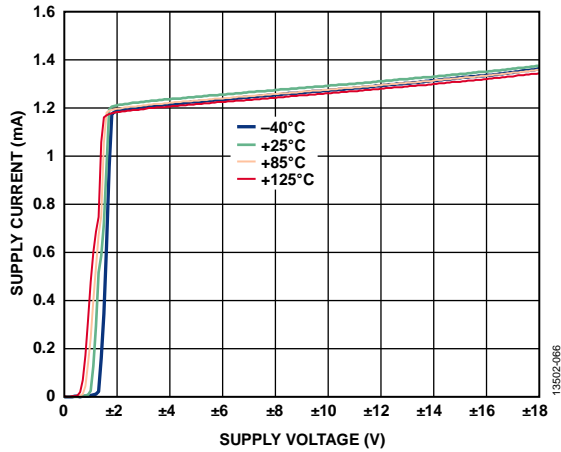


Figure 65. Supply Current ( $I_{SV}$ ) vs. Supply Voltage ( $V_{SV}$ ) for Various Temperatures

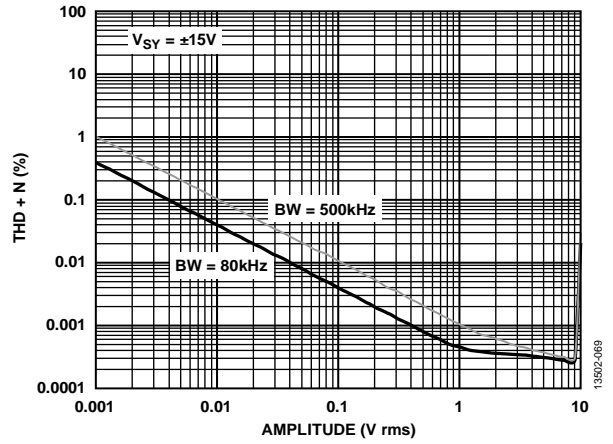


Figure 68. THD + Noise vs. Amplitude,  $V_{SV} = \pm 15V$

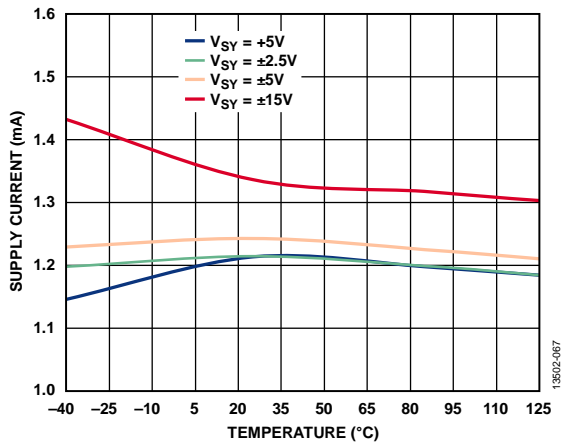


Figure 66. Supply Current ( $I_{SV}$ ) vs. Temperature for Various Supply Voltages

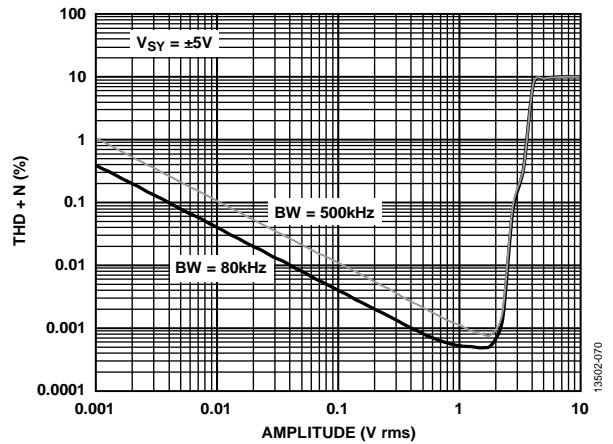


Figure 69. THD + Noise vs. Amplitude,  $V_{SV} = \pm 5V$

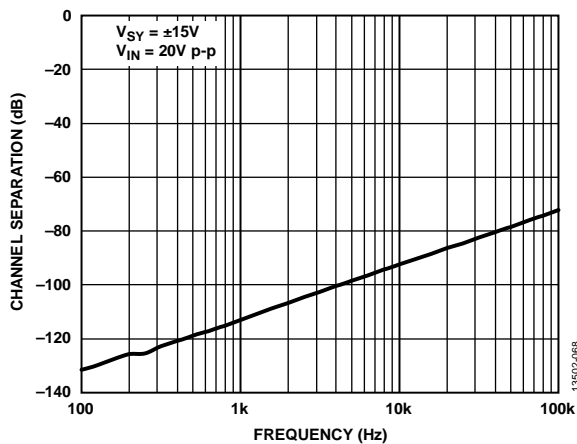


Figure 67. Channel Separation vs. Frequency,  $V_{SV} = \pm 15V$

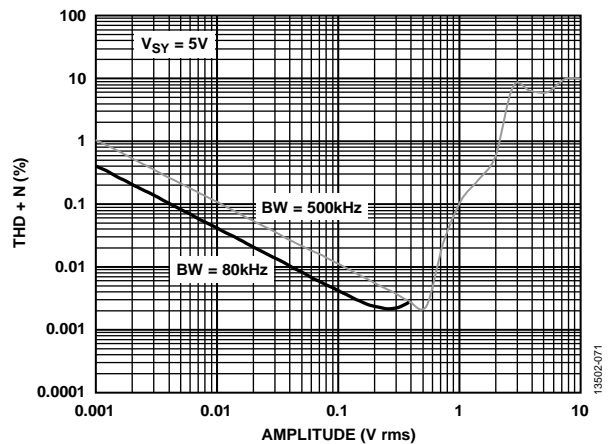


Figure 70. THD + Noise vs. Amplitude,  $V_{SV} = 5V$

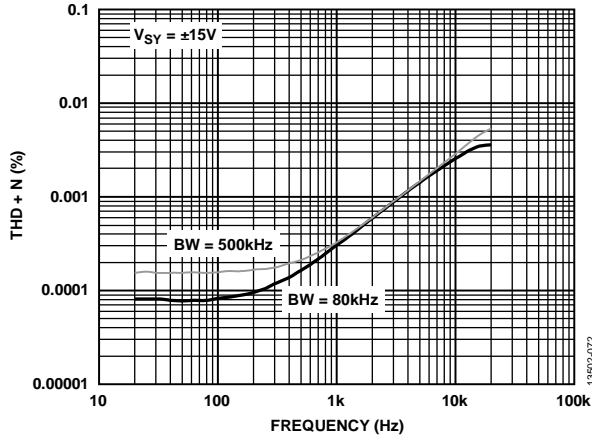


Figure 71. THD + Noise vs. Frequency,  $V_{SY} = \pm 15 V$

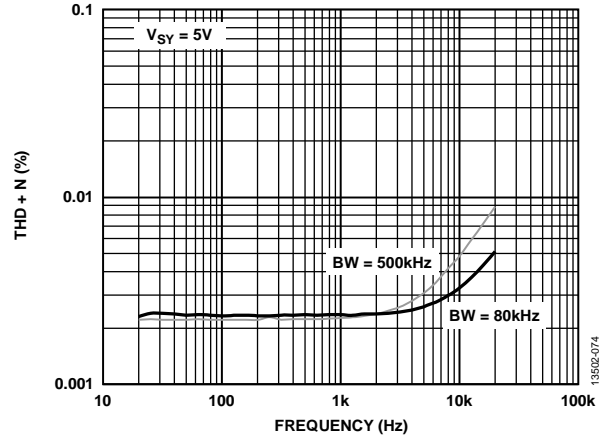


Figure 73. THD + Noise vs. Frequency,  $V_{SY} = 5 V$

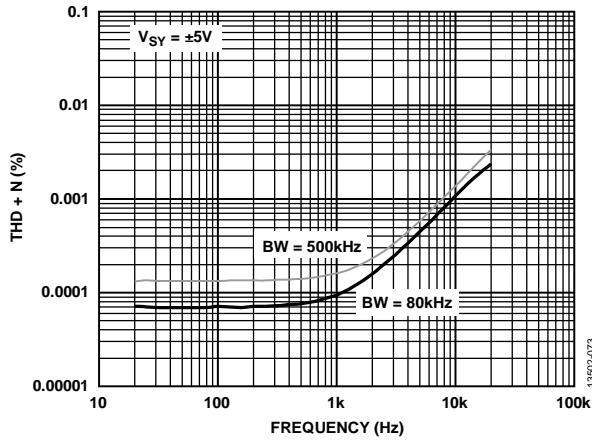


Figure 72. THD + Noise vs. Frequency,  $V_{SY} = \pm 5 V$

### THEORY OF OPERATION

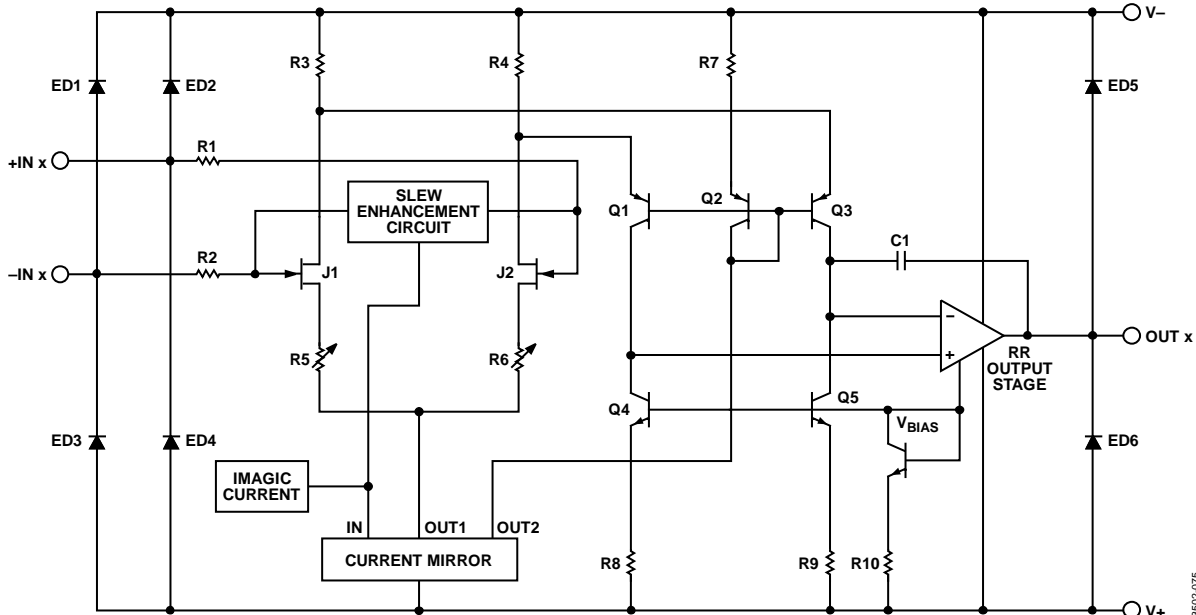


Figure 74. Simplified Circuit Diagram

### INPUT CHARACTERISTICS

The ADA4622-2 input stage consists of N-channel, JFETs that provide low offset, low noise, and high impedance. The minimum input common-mode voltage extends from  $-0.2\text{ mV}$  below  $V-$  to  $1\text{ V}$  less than  $V+$ . Driving the input closer to the positive rail causes loss of amplifier bandwidth and increased common-mode voltage error. Figure 75 shows the rounding of the output due to the loss of bandwidth. The input and output are superimposed.

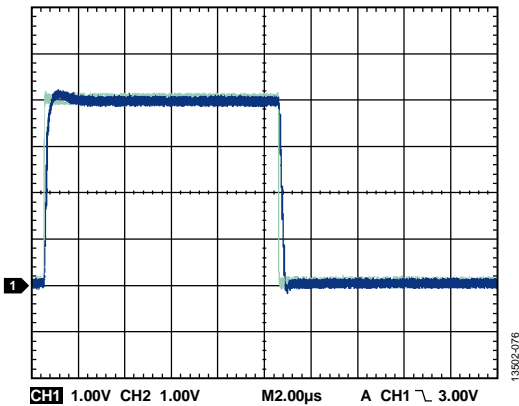


Figure 75. Bandwidth Limiting due to Headroom Requirements

The ADA4622-2 does not exhibit phase reversal for input voltages up to  $V+$ . For input voltages greater than  $V+$ , a  $10\text{ k}\Omega$  resistor in series with the noninverting input prevents phase reversal at the expense of higher noise (see Figure 76).

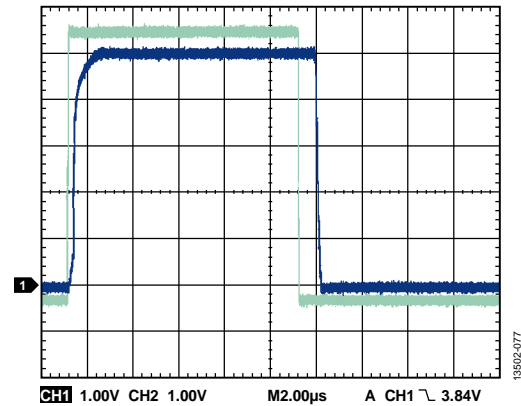


Figure 76. No Phase Reversal

Because the input stage uses N-channel JFETs, the input current during normal operation is negative. However, the input bias current changes direction as the input voltage approaches  $V+$  due to internal junctions becoming forward biased (see Figure 77).

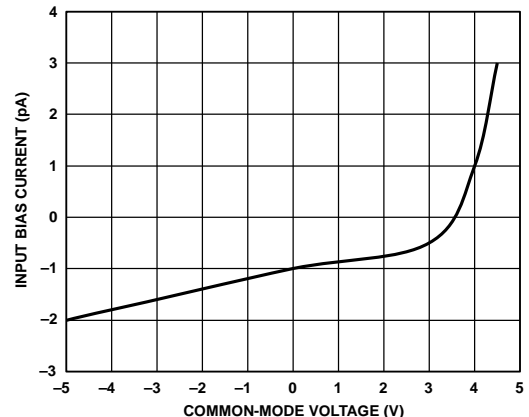


Figure 77. Input Bias Current vs. Common-Mode Voltage with  $\pm 5\text{ V}$  Supply

The ADA4622-2 is designed for 12 nV/ $\sqrt{\text{Hz}}$  wideband input voltage noise density and maintains low noise performance at low frequencies (see Figure 78). This noise performance, along with the low input current as well as low current noise, means that the ADA4622-2 contributes negligible noise for applications with a source resistance greater than 10 k $\Omega$  and at signal bandwidths greater than 1 kHz.

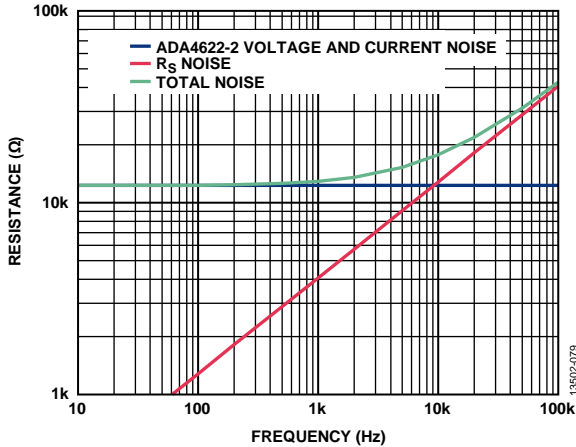


Figure 78. Total Noise vs. Source Resistance

**Input Overvoltage Protection**

The ADA4622-2 has internal protective circuitry that allows voltages as high as 0.3 V beyond the supplies applied at the input of either terminal without causing damage. Use a current limiting resistor in series with the input of the ADA4622-2 if the input voltage exceeds 0.3 V beyond the amplifier supply rails. If the overvoltage condition persists for more than a few seconds, the amplifier can be damaged.

For higher input voltages, determine the resistor value by

$$\frac{V_{IN} - V_{SY}}{R_s} \leq 10 \text{ mA}$$

where:

$V_{IN}$  is the input voltage.

$V_{SY}$  is the voltage of either the V+ pin or the V- pin.

$R_s$  is the series resistor.

With a very low input bias current of  $\pm 1.5$  nA maximum up to 125°C, higher resistor values can be used in series with the inputs without introducing large offset errors. A 1 k $\Omega$  series resistor allows the ADA4622-2 to withstand 10 V of continuous overvoltage and increases the noise by a negligible amount. A 5 k $\Omega$  resistor protects the inputs from voltages as high as 25 V beyond the supplies and adds less than 10  $\mu\text{V}$  to the amplifier offset voltage.

**EMI Rejection Ratio**

Figure 79 shows the electromagnetic interference rejection ratio (EMIRR) vs. frequency for the ADA4622-2.

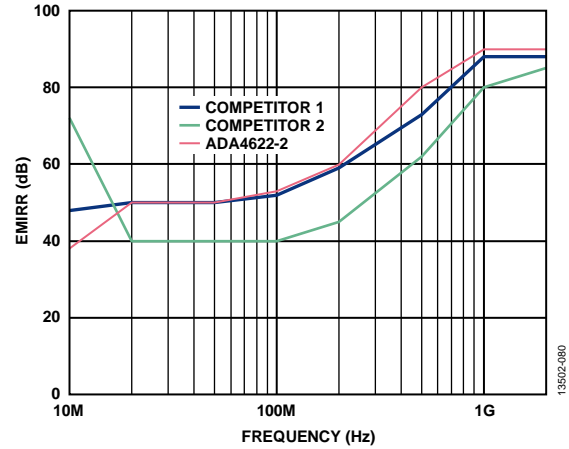


Figure 79. EMI Rejection Ratio (EMIRR) vs. Frequency

**OUTPUT CHARACTERISTICS**

The ADA4622-2 unique bipolar rail-to-rail output stage swings within 10 mV of the supplies with no external resistive load.

The ADA4622-2 approximate output saturation resistance is 24  $\Omega$ , sourcing or sinking. Use the output impedance to estimate the output saturation voltage when driving heavier loads. As an example, when driving 5 mA, the saturation voltage from either rail is roughly 120 mV.

If the ADA4622-2 output drives hard against the output saturation voltage, it recovers within 1.2  $\mu\text{s}$  of the input, returning to the linear operating region of the amplifier (see Figure 51 and Figure 54).

**Capacitive Load Drive Capability**

Direct capacitive loads interact with the effective output impedance of the ADA4622-2 to form an additional pole in the amplifier feedback loop, which causes excessive peaking on the pulse response or loss of stability. The worst case condition is when the device uses a single 5 V supply in a unity-gain configuration. Figure 80 shows the pulse response of the ADA4622-2 driving 500 pF directly.

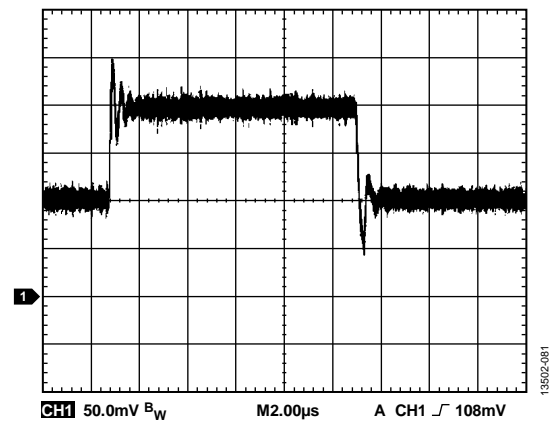


Figure 80. Pulse Response with 500 pF Load Capacitance



## APPLICATIONS INFORMATION

### RECOMMENDED POWER SOLUTION

The ADA4622-2 can be operated from ±2.5 V to ±15 volt dual supply or 5 V to 30 V single supply. The ADP7118 and ADP7182 are recommended to generate the clean positive and negative rails for the ADA4622-2. Both low dropout regulators (LDOs) are available in fixed output voltage or adjustable output voltage versions. To generate the input voltages for the LDOs, the ADP5070 dc-to-dc switching regulator is recommended. Figure 81 shows the recommended power solution configuration for the ADA4622-2.

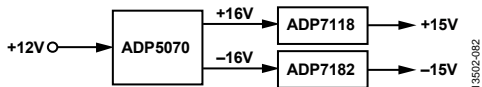


Figure 81. Power Solution Configuration for the ADA4622-2

Table 8. Recommended Power Management Devices

Product	Description
ADP5070	DC-to-DC switching regulator with independent positive and negative outputs
ADP7118	20 V, 200 mA, low noise, CMOS LDO regulator
ADP7182	-28 V, -200 mA, low noise, linear regulator

### MAXIMUM POWER DISSIPATION

The maximum power the ADA4622-2 can safely dissipate is limited by the associated rise in junction temperature. For plastic packages, the maximum safe junction temperature is 150°C. If this maximum temperature is exceeded, reduce the die temperature to restore proper circuit operation. Leaving the device in the overheated condition for an extended period can result in device burnout. To ensure proper operation, it is important to observe the Absolute Maximum Ratings and Thermal Resistance specifications.

### SECOND-ORDER LOW-PASS FILTER

Figure 82 shows the ADA4622-2 configured as a second-order, Butterworth, low-pass filter. With the values as shown, the corner frequency equals 200 kHz. Component selection is shown in the following equations:

$$R1 = R2 = \text{User Selected (Typical Values: 10 k}\Omega \text{ to 100 k}\Omega)$$

$$C1 = \frac{1.414}{2\pi f_{CUTOFF} \times R1}$$

$$C2 = \frac{0.707}{2\pi f_{CUTOFF} \times R1}$$

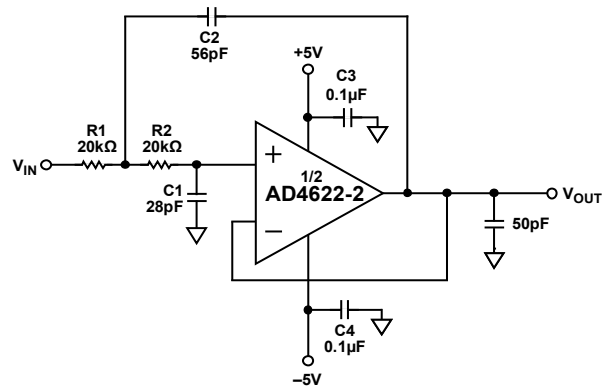


Figure 82. Second-Order, Butterworth, Low-Pass Filter

A plot of the filter is shown in Figure 83; greater than 35 dB of high frequency rejection is achieved.

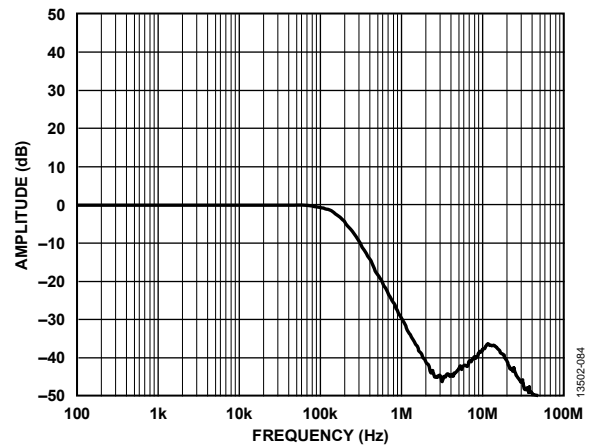


Figure 83. Frequency Response of the Filter

### WIDEBAND PHOTODIODE PREAMPLIFIER

The ADA4622-2 is an excellent choice for photodiode preamplifier application. The low input bias current minimizes the dc error at the preamplifier output. In addition, the high gain bandwidth product and low input capacitance maximizes the signal bandwidth of the photodiode preamplifier. Figure 84 shows the ADA4622-2 as a current to voltage (I to V) converter with an electrical model of a photodiode.

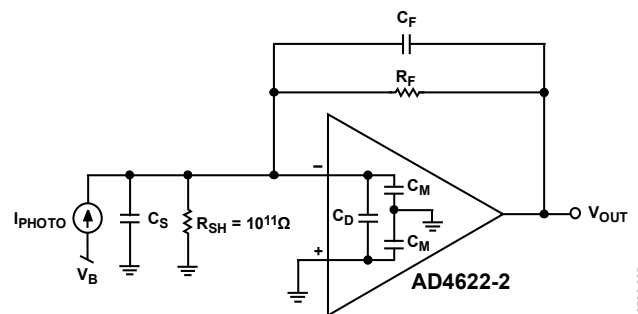


Figure 84. Wideband Photodiode Preamplifier

The transimpedance gain of the photodiode preamplifier is described by the following basic transfer function:

$$V_{OUT} = \frac{I_{PHOTO} \times R_F}{1 + sC_F R_F}$$

where

$I_{PHOTO}$  is the output current of the photodiode.

The parallel combination of  $R_F$  and  $C_F$  sets the signal bandwidth (see the I to V gain curve in Figure 86).

$s$  refers to the s-plane.

Note that  $R_F$  must be set so the maximum attainable output voltage corresponds to the maximum diode output current,  $I_{PHOTO}$ , which allows use of the full output swing. The attainable signal bandwidth with this photodiode preamplifier is a function of  $R_F$ , the gain bandwidth product ( $f_{GBP}$ ) of the amplifier, and the total capacitance at the amplifier summing junction, including  $C_S$  and the amplifier input capacitance,  $C_D$  and  $C_M$ .  $R_F$  and the total capacitance produce a pole with loop frequency ( $f_p$ ).

$$f_p = \frac{1}{2\pi R_F C_S}$$

With the additional pole from the amplifier open-loop response, the two-pole system results in peaking and instability due to an insufficient phase margin (see Figure 85).

Adding  $C_F$  creates a zero in the loop transmission that compensates for the effect of the input pole. This stabilizes the photodiode preamplifier design because of the increased phase margin. Adding  $C_F$  also sets the signal bandwidth (see Figure 86). The signal bandwidth and the zero frequency are determined by

$$f_z = \frac{1}{2\pi R_F C_F}$$

where  $f_z$  is the zero frequency.

Setting the zero at the  $f_x$  frequency maximizes the signal bandwidth with a 45° phase margin. Because  $f_x$  is the geometric mean of  $f_p$  and  $f_{GBP}$ , it can be calculated by

$$f_x = \sqrt{f_p \times f_{GBP}}$$

Combining these equations, the value of  $C_F$  that produces  $f_x$  is defined by

$$C_F = \sqrt{\frac{C_S}{2\pi \times R_F \times f_{GBP}}}$$

The frequency response in this case shows about 2 dB of peaking and 15% overshoot. Doubling  $C_F$  and halving the bandwidth results in a flat frequency response with about 5% transient overshoot.

The dominant sources of output noise in the wideband photodiode preamplifier design are the input voltage noise of the amplifier,  $V_{NOISE}$ , and the resistor noise due to  $R_F$ . The gray curve in Figure 86 shows the noise gain over frequencies for the photodiode preamplifier. Calculate the noise bandwidth at the  $f_N$  frequency by

$$f_N = \frac{f_{GBP}}{(C_S + C_F)/C_F}$$

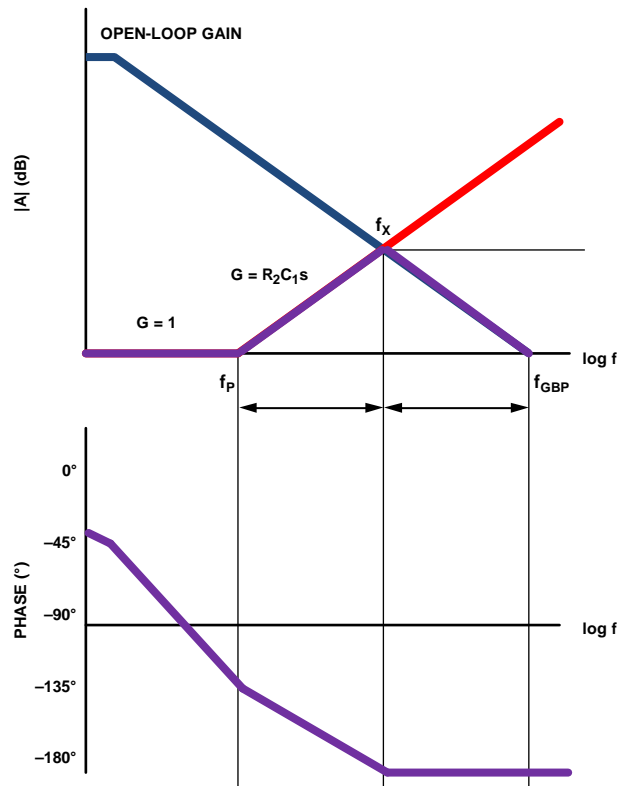


Figure 85. Gain and Phase Plot of the Transimpedance Amplifier Design, Without Compensation

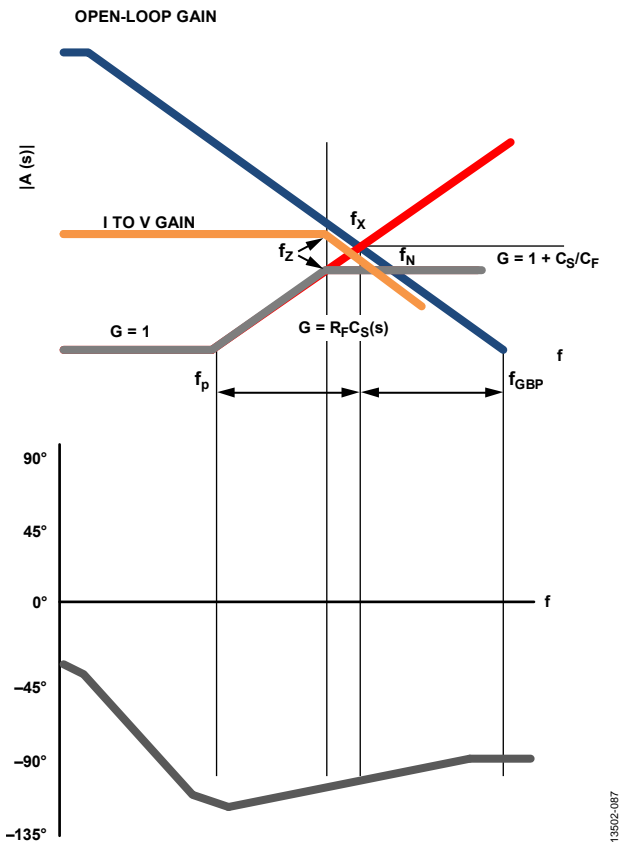


Figure 86. Gain and Phase Plot of the Transimpedance Amplifier Design with Compensation

Figure 87 shows the ADA4622-2 configured as a transimpedance photodiode amplifier. The amplifier is used in conjunction with a photodiode detector with an input capacitance of 5 pF. Figure 88 shows the transimpedance response of the ADA4622-2 when I<sub>PHOTO</sub> is 1 μA p-p. The amplifier has a bandwidth of 2 MHz when it is maximized for a 45° phase margin with C<sub>F</sub> = 2 pF. Note that with the PCB parasitics added to C<sub>F</sub>, the peaking is only 0.5 dB and the bandwidth is slightly reduced.

Increasing C<sub>F</sub> to 3 pF completely eliminates the peaking. However, increasing C<sub>F</sub> to 3 pF reduces the bandwidth to 1 MHz.

Table 9 shows the noise sources and total output noise for the photodiode preamplifier, where the preamplifier is configured to have a 45° phase margin for maximum bandwidth and f<sub>Z</sub> = f<sub>X</sub> = f<sub>N</sub> in this case.

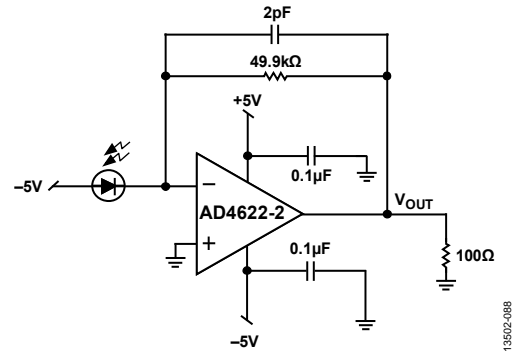


Figure 87. Photodiode Preamplifier

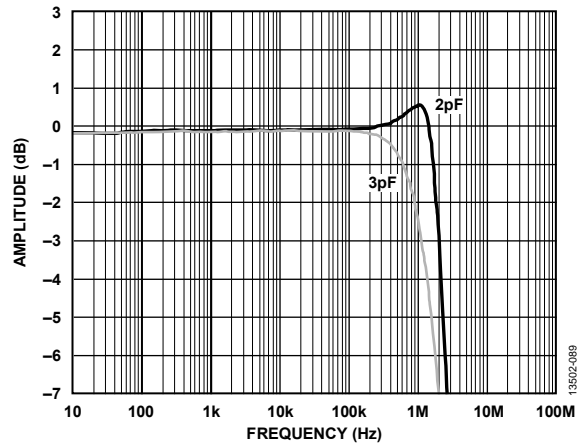


Figure 88. Photodiode Preamplifier Frequency Response

Table 9. RMS Noise Contributions of the Photodiode Preamplifier

Contributor	Expression	RMS Noise (μV) <sup>1</sup>
R <sub>F</sub>	$\sqrt{4kT \times R_F \times f_N \times \frac{\pi}{2}}$	50.8
V <sub>NOISE</sub>	$V_{NOISE} \times \sqrt{\frac{(C_S + C_M + C_F + C_D)}{C_F}} \times \sqrt{\frac{\pi}{2} \times f_N}$	131.6
Root Sum Square (RSS) Total	$\sqrt{R_F^2 \times V_{NOISE}^2}$	141

<sup>1</sup> RMS noise with R<sub>F</sub> = 50 kΩ, C<sub>S</sub> = 5 pF, C<sub>F</sub> = 2 pF, C<sub>M</sub> = 3.7 pF, and C<sub>D</sub> = 0.4 pF.

**PEAK DETECTOR**

A peak detector captures the peak value of a signal and produces an output equal to it. By taking advantage of the dc precision and super low input bias current of the JFET input amplifiers, such as the ADA4622-2, a highly accurate peak detector can be built, as shown in Figure 89.

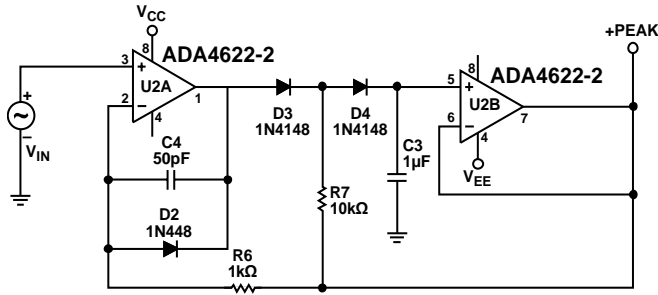


Figure 89. Positive Peak Detector

13802-090

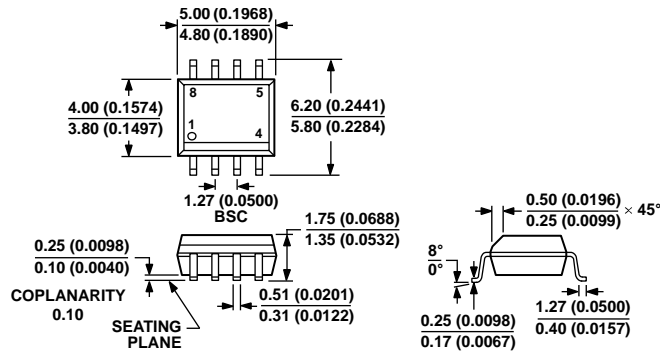
In this application, D3 and D4 act as unidirectional current switches that open when the output is kept constant in hold mode.

To detect a positive peak, U2A drives C3 through D3 and drives D4 until C3 is charged to a voltage equal to the input peak value.

Feedback from the output of the U2B (positive peak) through R6 limits the output voltage of U2A. After detecting the peak, the output of U2A swings low but is clamped by D2. D3 reverses bias and the common node of D3, D4, and R7 is held to a voltage equal to positive peak by R7. The voltage across D4 is 0 V; therefore, the leakage is small. The bias current of U2B is also small. With almost no leakage, C3 has a long hold time.

The ADA4622-2, shown in Figure 89, is a perfect fit for building a peak detector because U2A requires dc precision and high output current during fast peaks and U2B requires low input bias current ( $I_B$ ) to minimize capacitance discharge between peaks. A low leakage and low dielectric absorption capacitor, such as polystyrene or polypropylene, is required for C3. Reversing the diode directions causes the circuit to detect negative peaks.

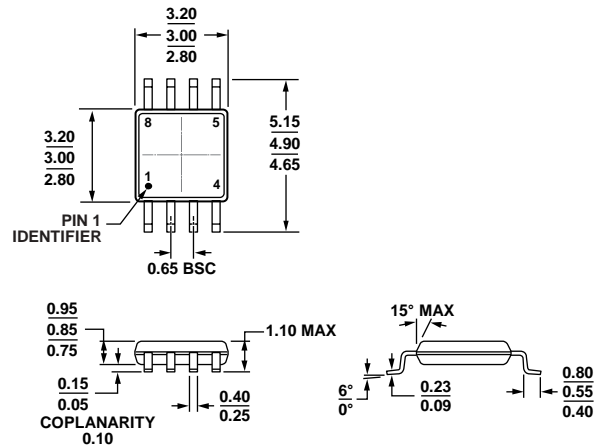
# OUTLINE DIMENSIONS



COMPLIANT TO JEDEC STANDARDS MS-012-AA  
CONTROLLING DIMENSIONS ARE IN MILLIMETERS; INCH DIMENSIONS (IN PARENTHESES) ARE ROUNDED-OFF MILLIMETER EQUIVALENTS FOR REFERENCE ONLY AND ARE NOT APPROPRIATE FOR USE IN DESIGN.

Figure 90. 8-Lead Standard Small Outline Package [SOIC\_N] Narrow Body (R-8)

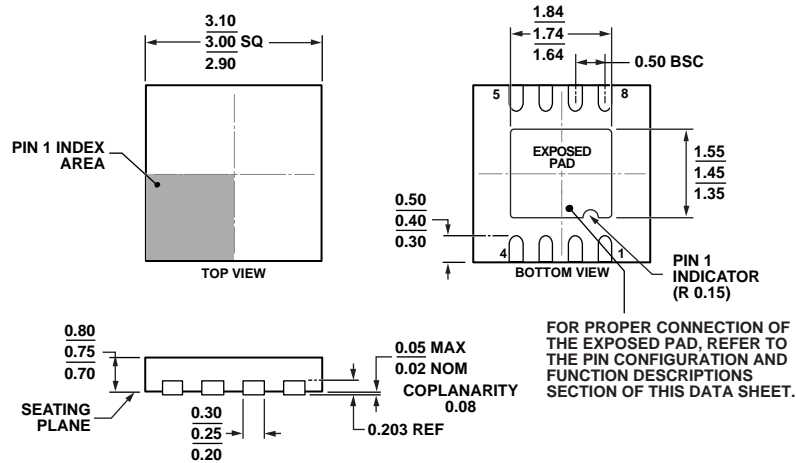
Dimensions shown in millimeters and (inches)



COMPLIANT TO JEDEC STANDARDS MO-187-AA

Figure 91. 8-Lead Mini Small Outline Package [MSOP] (RM-8)

Dimensions shown in millimeters



COMPLIANT TO JEDEC STANDARDS MO-229-WEED

Figure 92. 8-Lead Lead Frame Chip Scale Package [LFCSPP]  
 3 mm × 3 mm Body and 0.75 mm Package Height  
 (CP-8-13)

Dimensions shown in millimeters

12-07-2010-A

**ORDERING GUIDE**

Model <sup>1</sup>	Temperature Range	Package Description	Package Option	Branding
ADA4622-2ACPZ-R7	-40°C to +125°C	8-Lead Lead Frame Chip Scale Package [LFCSPP]	CP-8-13	A3D
ADA4622-2ACPZ-RL	-40°C to +125°C	8-Lead Lead Frame Chip Scale Package [LFCSPP]	CP-8-13	A3D
ADA4622-2ARMZ	-40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	A3D
ADA4622-2ARMZ-R7	-40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	A3D
ADA4622-2ARMZ-RL	-40°C to +125°C	8-Lead Mini Small Outline Package [MSOP]	RM-8	A3D
ADA4622-2ARZ	-40°C to +125°C	8-Lead Standard Small Outline Package [SOIC_N]	R-8	
ADA4622-2ARZ-R7	-40°C to +125°C	8-Lead Standard Small Outline Package [SOIC_N]	R-8	
ADA4622-2ARZ-RL	-40°C to +125°C	8-Lead Standard Small Outline Package [SOIC_N]	R-8	
ADA4622-2BRZ	-40°C to +125°C	8-Lead Standard Small Outline Package [SOIC_N]	R-8	
ADA4622-2BRZ-R7	-40°C to +125°C	8-Lead Standard Small Outline Package [SOIC_N]	R-8	
ADA4622-2BRZ-RL	-40°C to +125°C	8-Lead Standard Small Outline Package [SOIC_N]	R-8	

<sup>1</sup> Z = RoHS Compliant Part.



Компания «ЭлектроПласт» предлагает заключение долгосрочных отношений при поставках импортных электронных компонентов на взаимовыгодных условиях!

Наши преимущества:

- Оперативные поставки широкого спектра электронных компонентов отечественного и импортного производства напрямую от производителей и с крупнейших мировых складов;
- Поставка более 17-ти миллионов наименований электронных компонентов;
- Поставка сложных, дефицитных, либо снятых с производства позиций;
- Оперативные сроки поставки под заказ (от 5 рабочих дней);
- Экспресс доставка в любую точку России;
- Техническая поддержка проекта, помощь в подборе аналогов, поставка прототипов;
- Система менеджмента качества сертифицирована по Международному стандарту ISO 9001;
- Лицензия ФСБ на осуществление работ с использованием сведений, составляющих государственную тайну;
- Поставка специализированных компонентов (Xilinx, Altera, Analog Devices, Intersil, Interpoint, Microsemi, Aeroflex, Peregrine, Syfer, Eurofarad, Texas Instrument, Miteq, Cobham, E2V, MA-COM, Hittite, Mini-Circuits, General Dynamics и др.);

Помимо этого, одним из направлений компании «ЭлектроПласт» является направление «Источники питания». Мы предлагаем Вам помощь Конструкторского отдела:

- Подбор оптимального решения, техническое обоснование при выборе компонента;
- Подбор аналогов;
- Консультации по применению компонента;
- Поставка образцов и прототипов;
- Техническая поддержка проекта;
- Защита от снятия компонента с производства.



#### Как с нами связаться

**Телефон:** 8 (812) 309 58 32 (многоканальный)

**Факс:** 8 (812) 320-02-42

**Электронная почта:** [org@eplast1.ru](mailto:org@eplast1.ru)

**Адрес:** 198099, г. Санкт-Петербург, ул. Калинина, дом 2, корпус 4, литера А.